

- **Half Shell cycling and testing in Frascati.  
(equipment, specs and approaches)**
- **Half Shell Clamping in Frascati,  
Cycling and testing (all Layers)**

Marianna Testa LNF-INFN

OEC Integration Workshop 1 February 2024

With contributions from

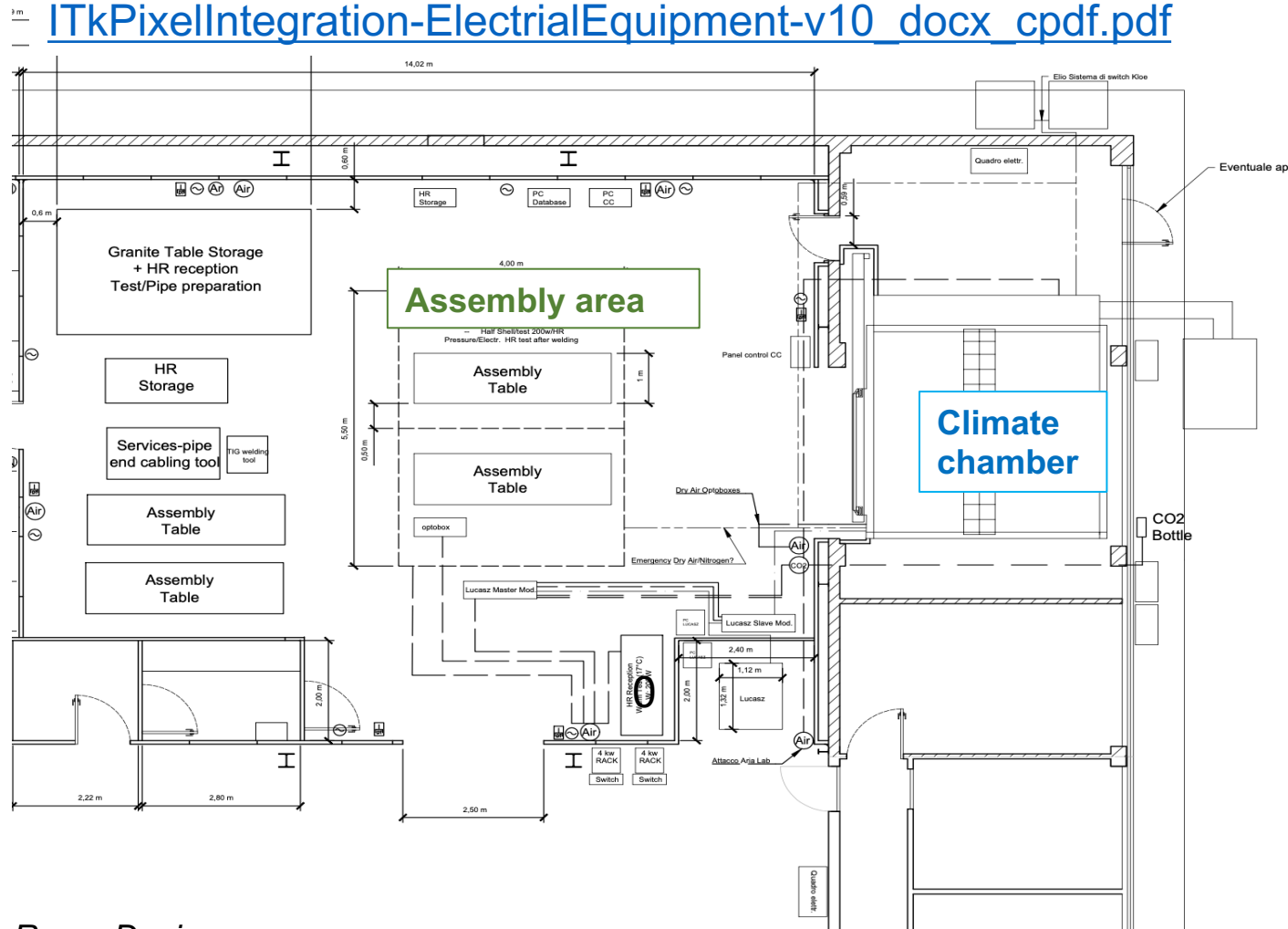
Z. Chubinidze, B.Buadze, L.Vannoli, P. Albicocco

Thanks to C. Gemme for useful discussion and suggestions

# EC Testing during Integration

Baseline as described in

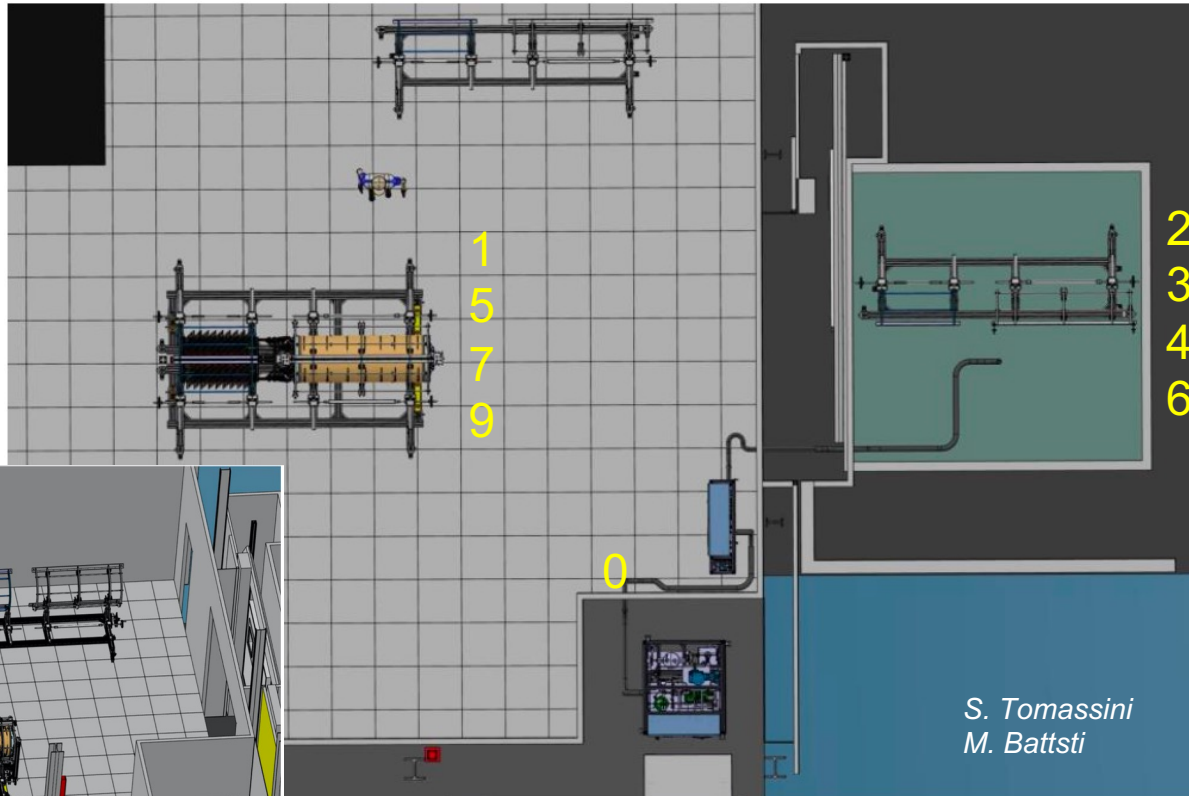
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0. Half-ring reception test
1. insertion of services – cooling lines, data/pwr cable - and test
2. Insertion of half-ring with silicon modules
3. Low Power mode connectivity test
4. Testing connectivity with cold CO<sub>2</sub>.
5. Thermo-cycles test with detector Off
6. Testing again connectivity with cold CO<sub>2</sub>
7. Mating couple of half-shells to form a layer
8. Testing connectivity of complete layer cooling with Lp mode /warm CO<sub>2</sub>
9. Bring layer on platform
10. Repeat for the three layers
11. Final test on transport box

Clean Room Design:  
E. Dane', M. Testa

# EC Testing during Integration



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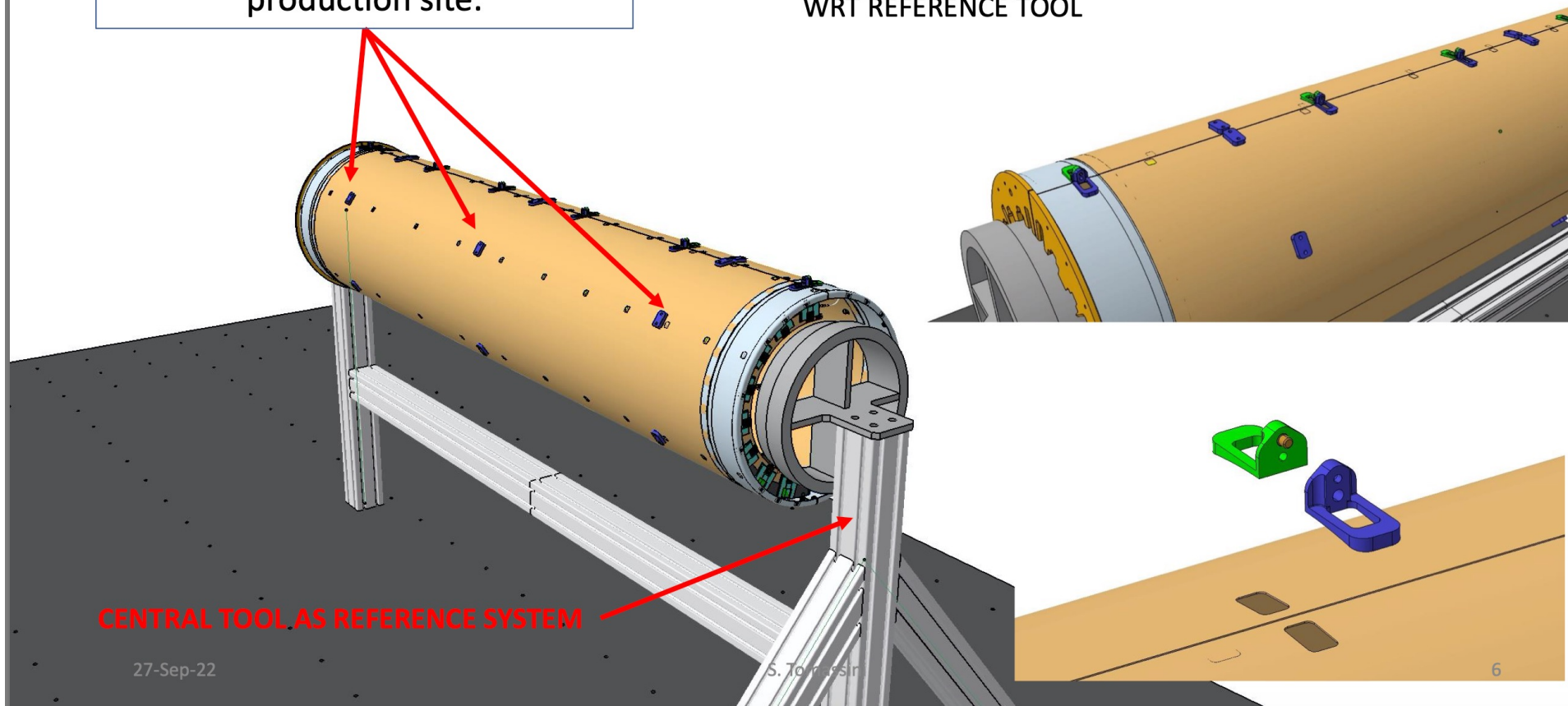
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# HS and tooling preparation - 1

## Integration Sequence

L2\_L3\_L4 - Interface Plates (n.12)  
already glued on CF shells at the  
production site.

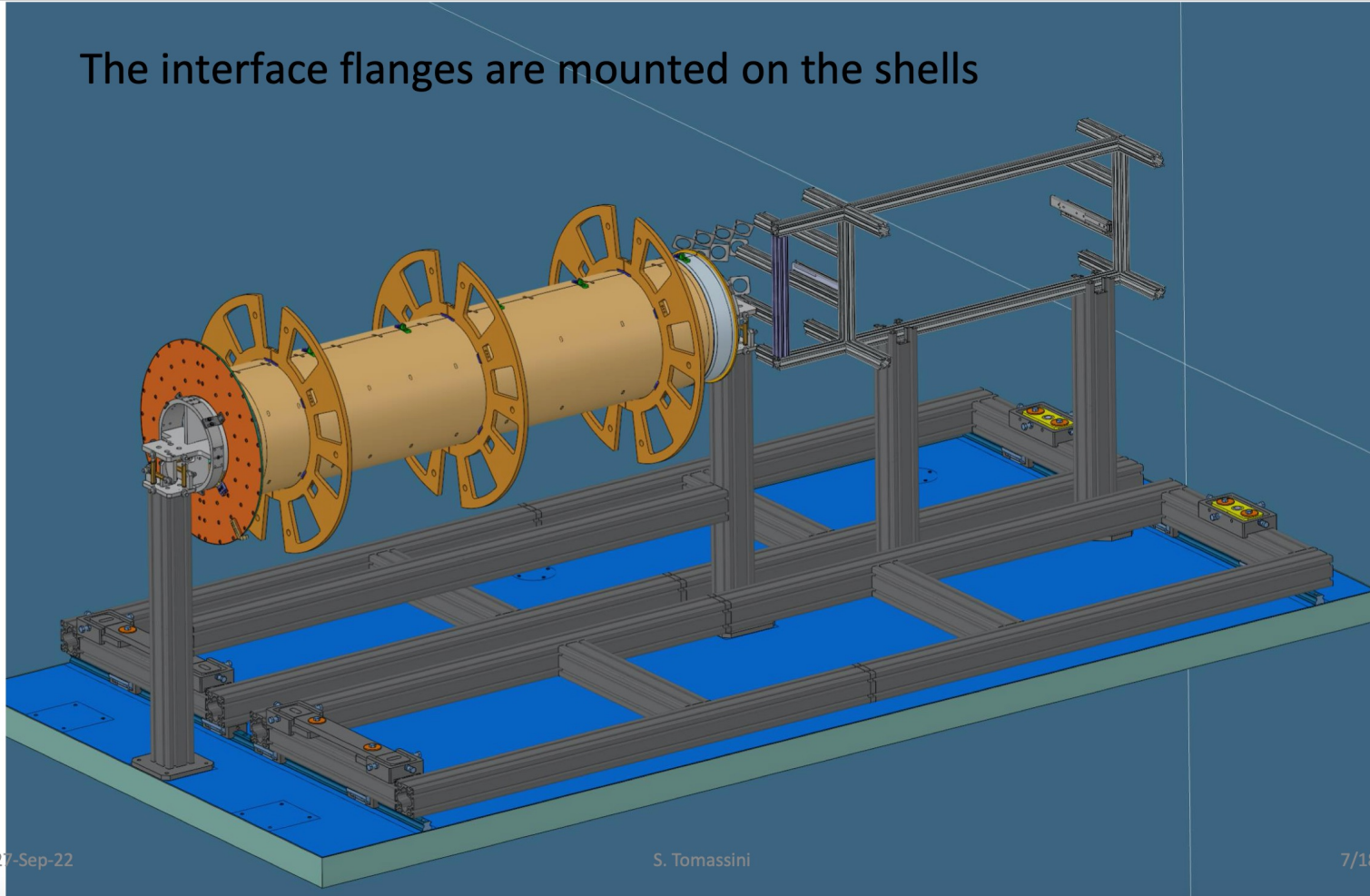
1. BARE SHELLS ARE INSTALLED  
AND CLAMPED ON THE  
REFERENCE TOOL
2. THE CILYNDER IS ALIGNED  
WRT REFERENCE TOOL



[GM | Tomassini 27Nov2022 talk](#)

# HS and tooling preparation - 2

The interface flanges are mounted on the shells



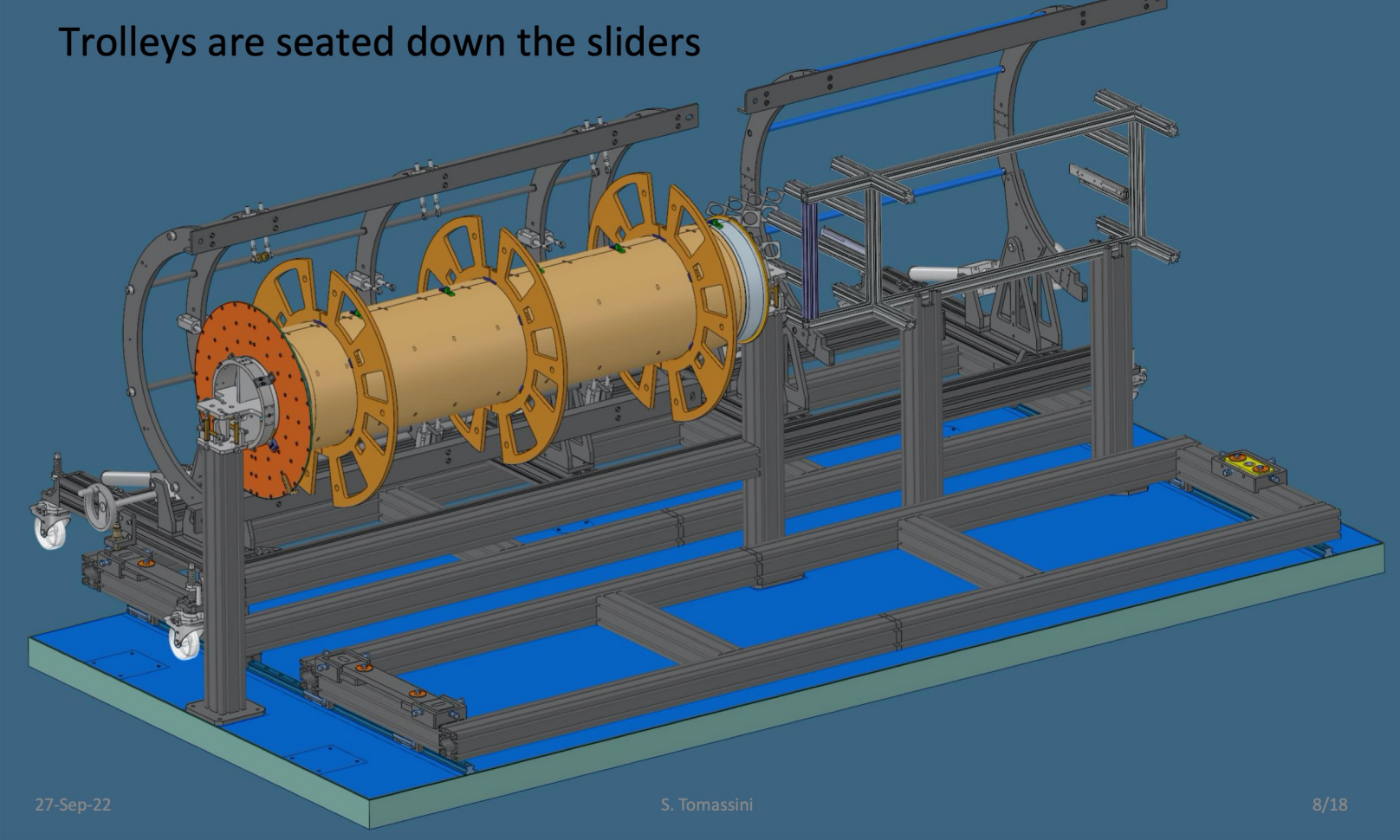
27-Sep-22

S. Tomassini

7/18

[Tomassini\\_27Nov2022 talk](#)

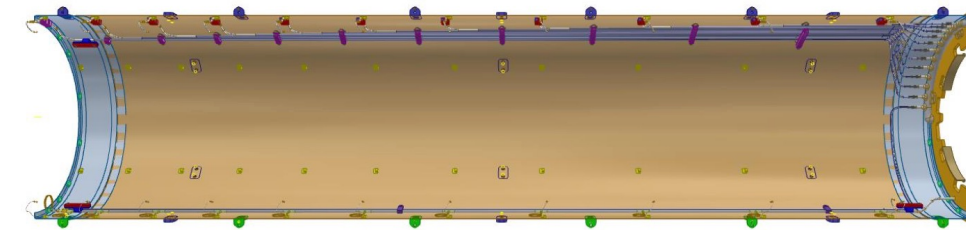
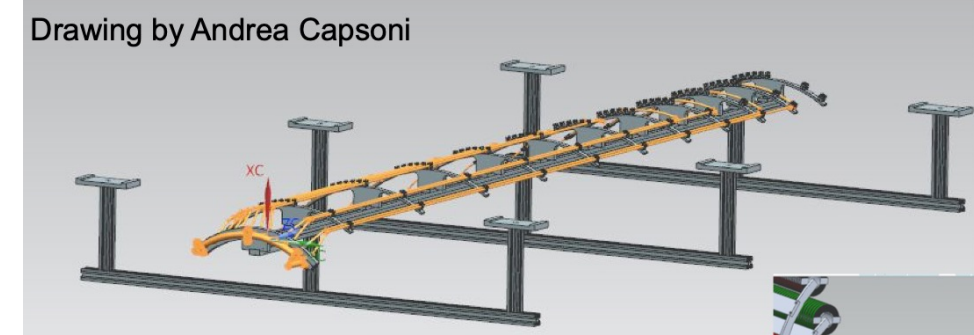
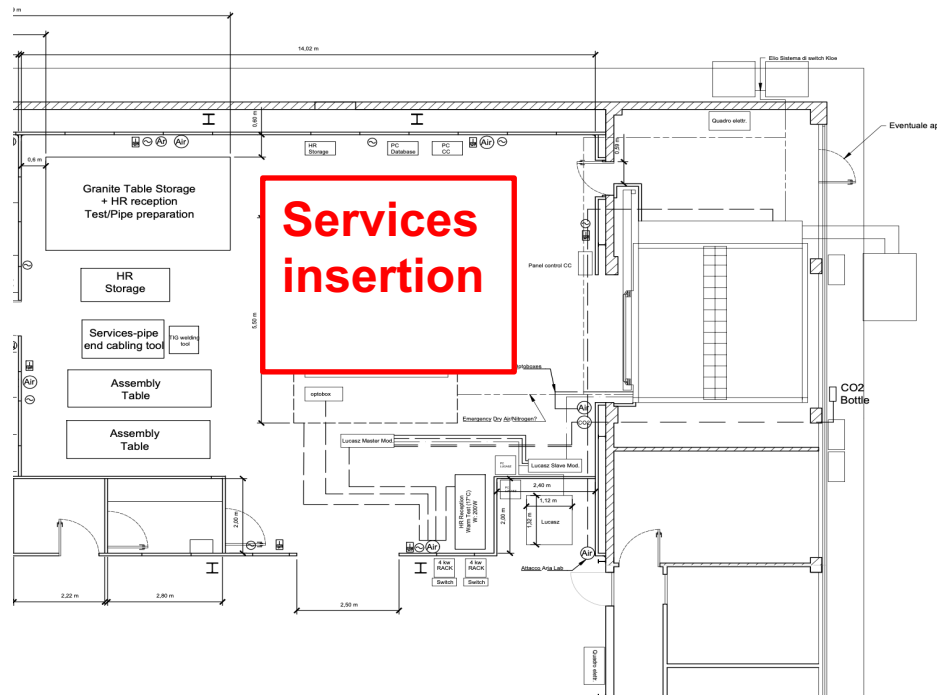
# HS and tooling preparation - 3



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# Insertion of cooling type-1 services

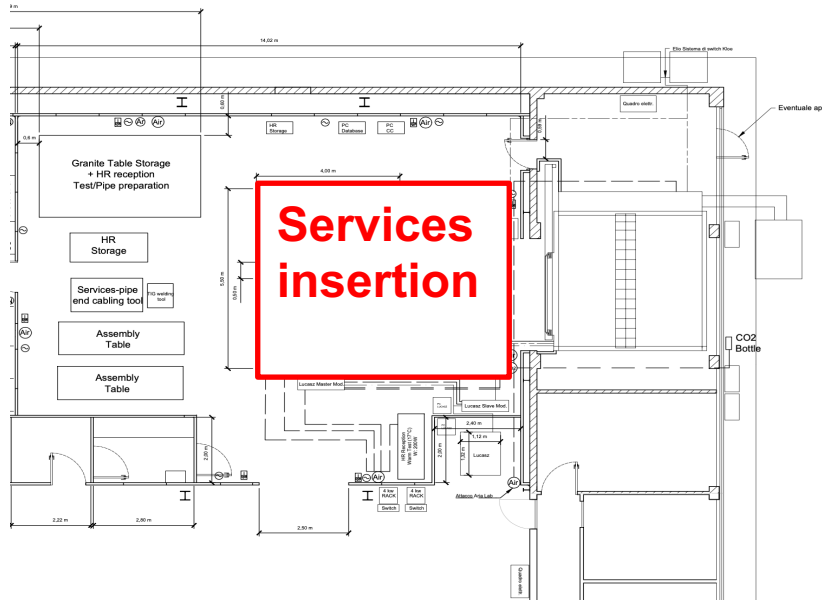
## Insertion of cooling lines



- Type 1 pipes and capillaries will be isolated from half-shells or any other conductive surface using ULTEM clip
- The resistance to the support structure will be measured and recorded to ensure compliance with the grounding and shielding including ground fault monitors specifications

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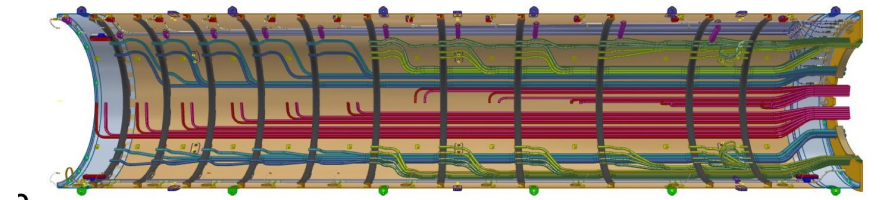
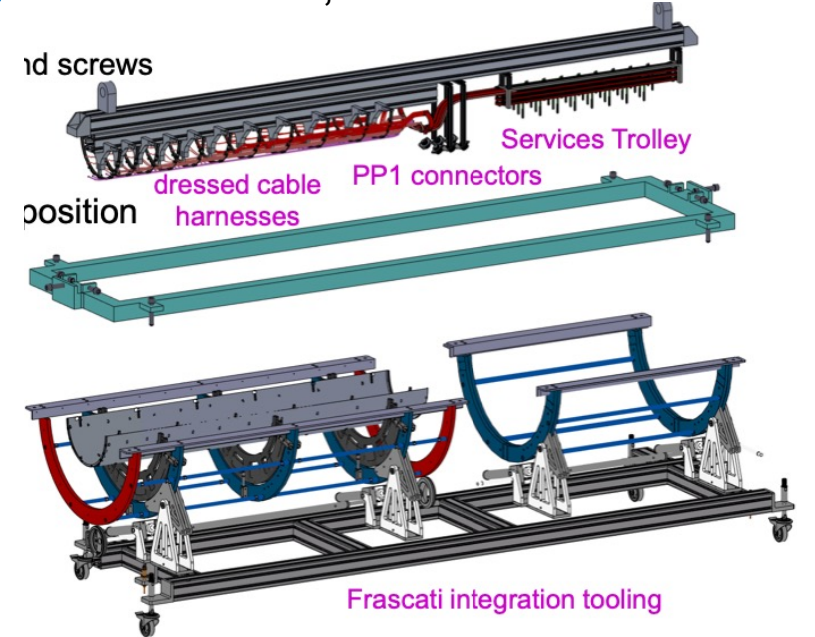
# Insertion of data/pwr and env type-1 services



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- Electrical **continuity** of HV-, LV-, Tiloock-, CANbus and VCAN-lines, env. bundle, from terminations PCB to **PP1 connectors**
- Localized heat input / 'cold-spray' will be used to make sure the sensors respond appropriately (check on humidity sensors TBD).
- **Mapping** of pwr and env bundles PP2/PP3 and PSU
- Electrical continuity of **data** cables from firefly to **termination boards**
- **Mapping** of twinax cables with

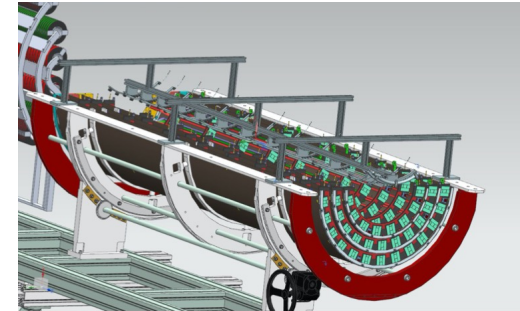
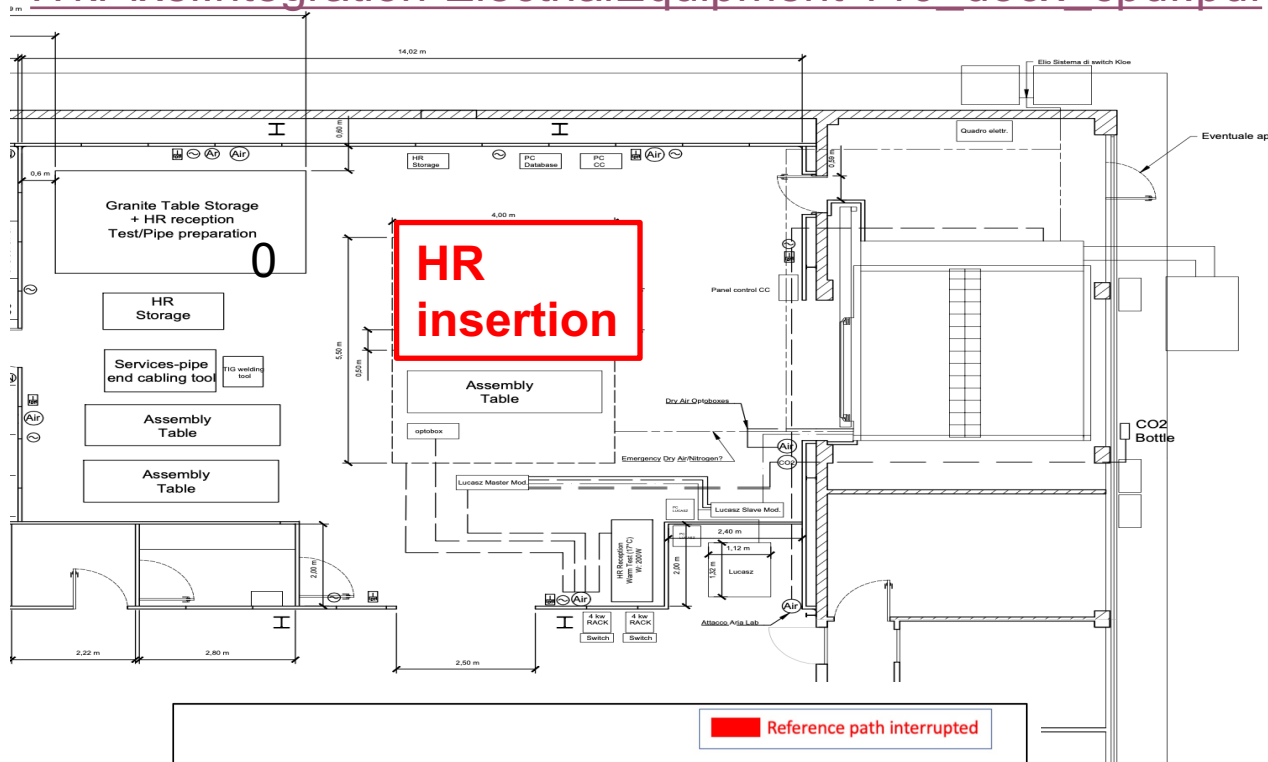
O.Shea, S. Eisenhardt



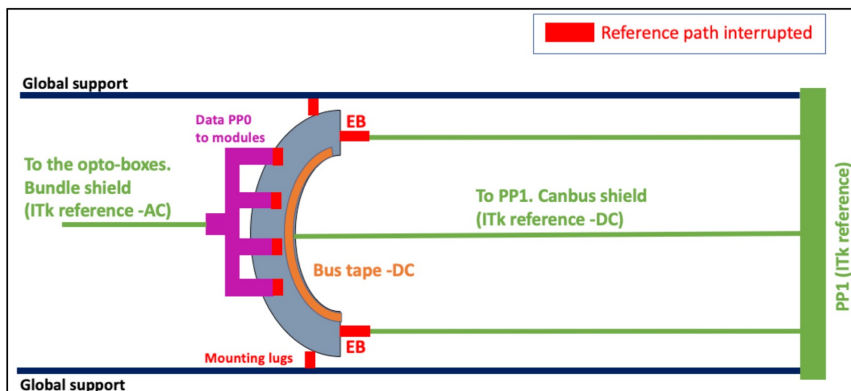


# Insertion of Half-Rings & connection to Electrical services

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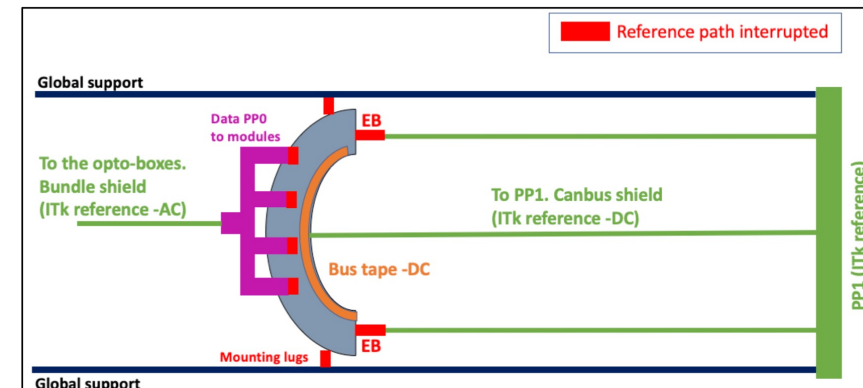
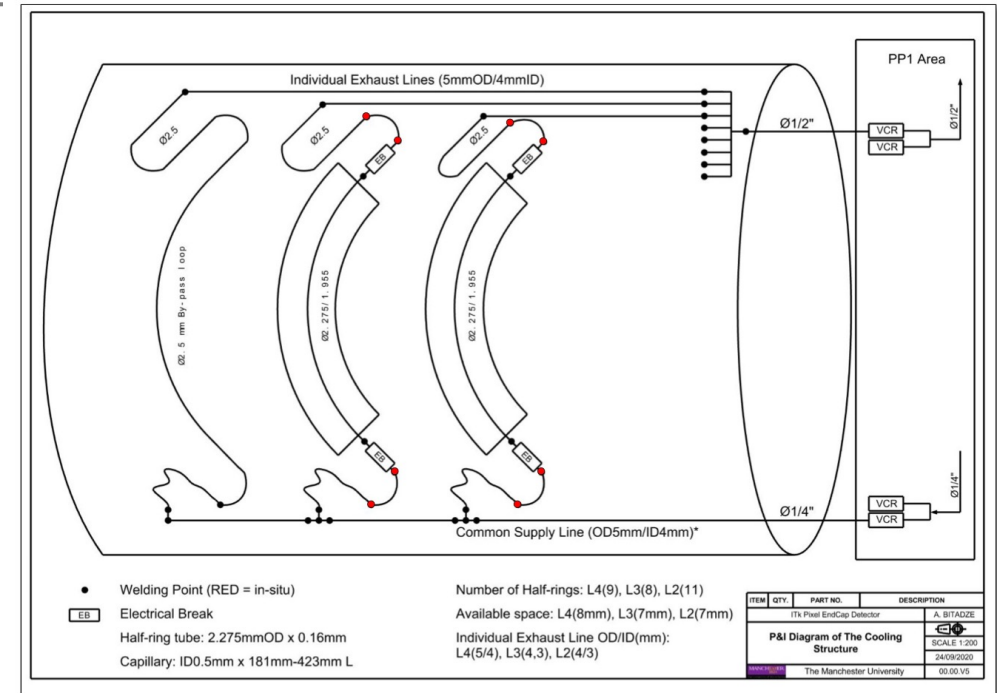


- Insertion of Half-ring
- **G&S check:** isolation between HR and HS
  - The isolation resistance between ground pads on HV EoS on the half-ring to the Type-1 cooling manifolds and the the half-cylinder will be recorded.
- Connection with **services**
  - From here HR is at the ITk ground via Canbus shield
- HR tested in **low power mode**
- Need of convective cooling fans, according to tests ( shown later)



# Welding

- 4 welds per HR
  - Leak test
  - Pressure test 162 bar
  - Leak test
  - Next slides about gas ( Ar in SR1 )
- Re-test with low power mode
  - Check no damage on modules/services
- Repeat until Half-shell is populated



# Welding

- In SR1 Argon is used:
- [https://edms.cern.ch/ui/file/2913775/1/Procedure\\_document\\_-\\_SR1\\_weld\\_proof\\_test\\_DRAFT\\_V1x\\_docx\\_cp.pdf](https://edms.cern.ch/ui/file/2913775/1/Procedure_document_-_SR1_weld_proof_test_DRAFT_V1x_docx_cp.pdf). ?

Since the presence of traces of water in the ITk on-detector cooling distribution system is highly undesirable, a hydrostatic proof test cannot be applied. The ITk on-detector cooling system welded joints proof test is a pneumatic test. The use of Nitrogen as a proof test fluid is undesirable, as it does not allow to use a sniffer to find leaks if necessary. Both Argon and Helium are preferred for the Proof test, but since **Argon** is cheaper, it is chosen as the Proof test fluid.

Information from C. Degeorge (thanks!)

- At the very beginning of the high pressure test we put 25% of the operational pressure, so, in our case 32,5 bar.  
→ Possible to find a leak which can be invisible during a vacuum leak test.
- Under this pressure (32,5 bar) the tested manifold is officially accessible and a leak can be found using the Argon sniffer. This is not possible with Nitrogen or Air

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# Connectivity Test on each HR after welding with Low Power Mode

# Connectivity Test with Low Power Mode

Electrical Connectivity	
Already Tested	To be Tested
Bus Tape-EoS (HV,LV, Vcan,Canbus, T-ilock)	Type1 bundle - EoS connection
Type-1 pwr cable and connectors	
PP1 connectros, Type2, Type3 cables (all off-detector cables)	
Mapping	

- **Granularity:** one Type1 bundle per time
- **Connectivity of HV/LV/Canbus/Vcan/ T-lock lines**
  - Switch on modules. Record T,V, I
  - Threshold scan specifically for HV connection
    - Check noise from s-curve
    - TBC: threshold scan with LP mode possible?

Work in progress: Details will come when equipment will be available

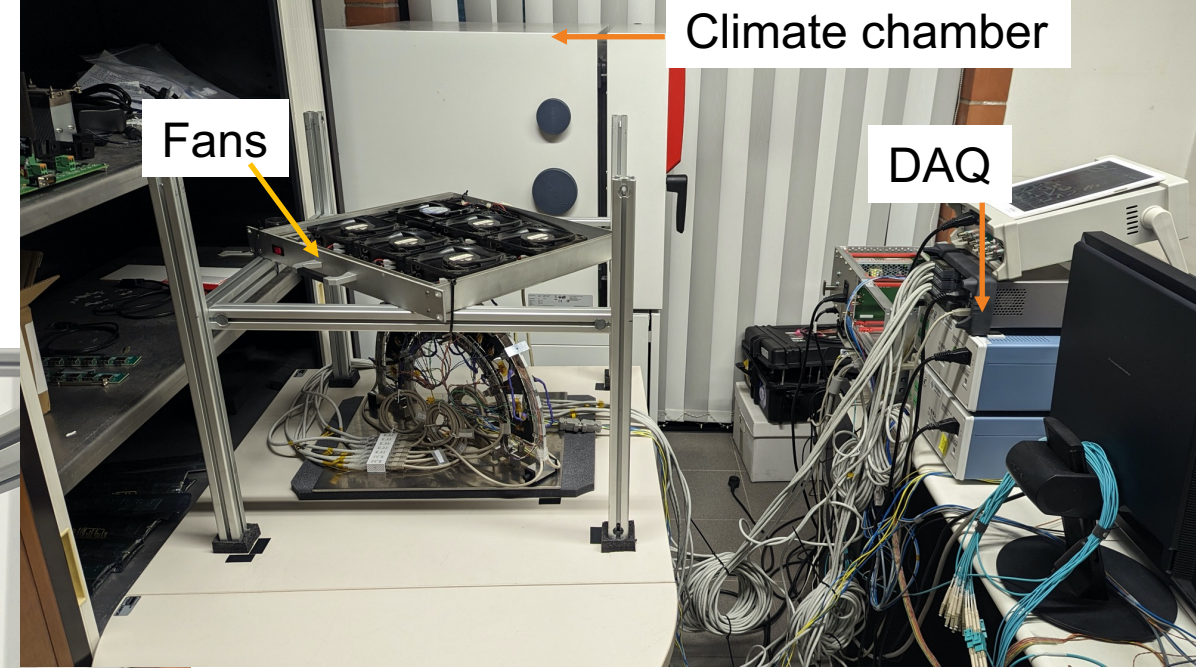
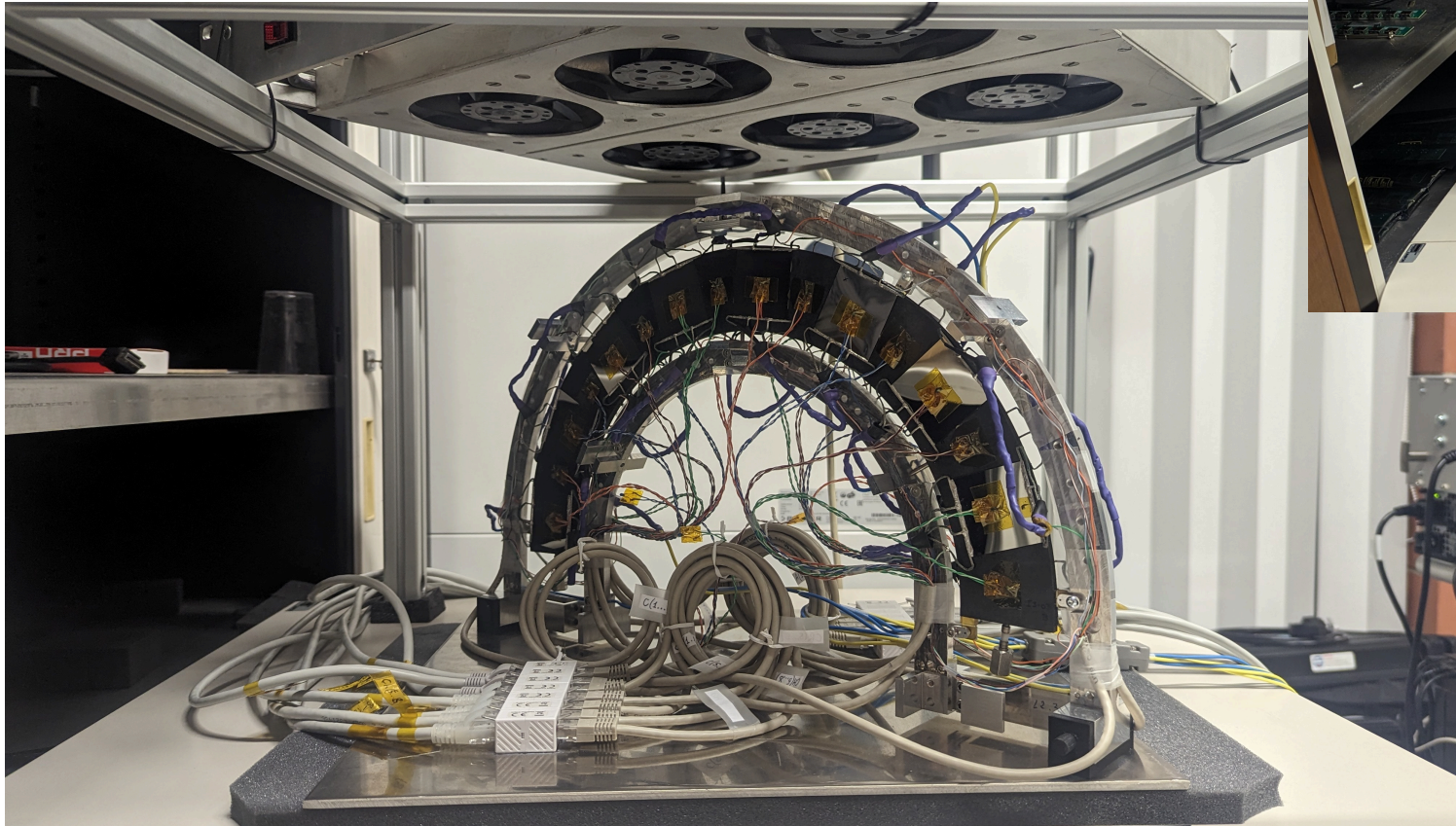
# Connectivity Test with Low Power Mode

Data Connectivity	
Already Tested	To be Tested
Module-PP0	Twinax – PP0
Twinax bundle terminations	
Extension- twinax bundle	
Fibers & their connectors	
Mapping optoboards-twinax cables	

- **Granularity:** one PP0-twinax-extension per time
- **DAQ Felix-Module** basic connectivity :
  - Optical and electrical alignment
- **Downlink** checks from Felix to Modules:
  - Configure a FE in each module
- **Uplink** check: digital scans

Work in progress: Details will come when equipment will be available

# Low Power Mode on Thermal Half Rings

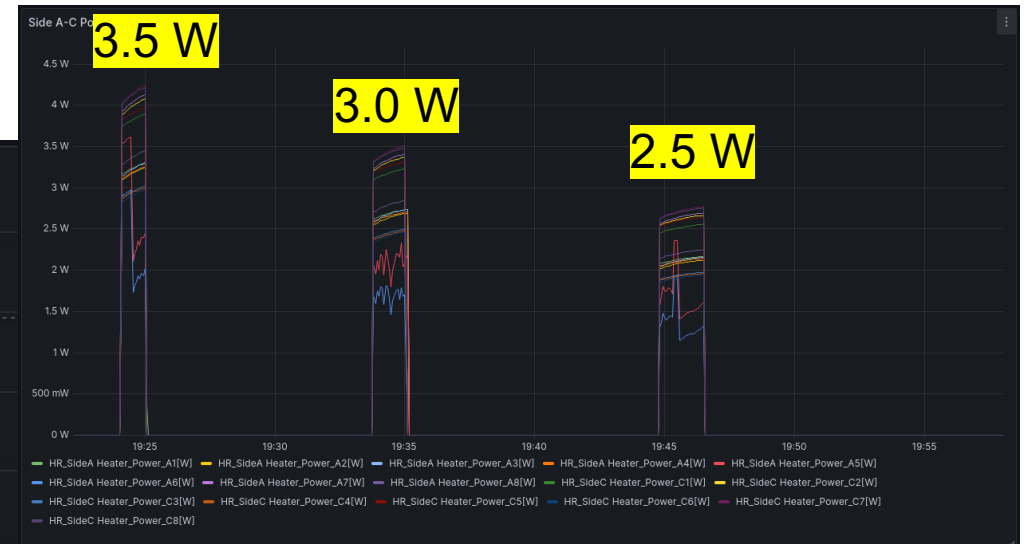


Thanks a lot to Manchester group  
( Ben, Jo, Paki, Juliette)  
for providing the thermal HR  
and making possibility to start this activity !

Z. Chubinidze, B. Buadze

# Low Power Mode on Thermal Half Rings: no Fan

Reach 40 C in ~ 1min



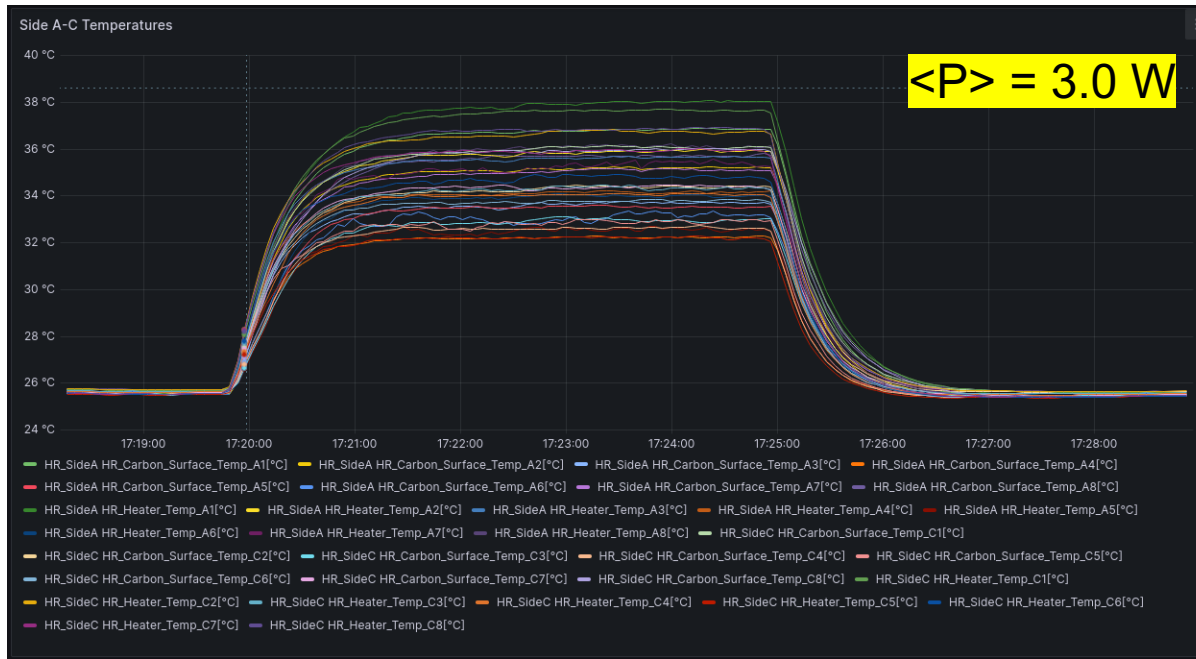
Average power values among heaters

Z. Chubinidze



# Low Power Mode on Thermal Half Rings using Fans

Heaters with $P > 3W$	C7	C8	A7	C2	C5	C6
Air velocity m/s	3.3	3.2	3.6	5.3	4.2	4.3



air velocity  $\geq 3.2$  m is enough to maintain  $T < 40$  C

Z. Chubinidze

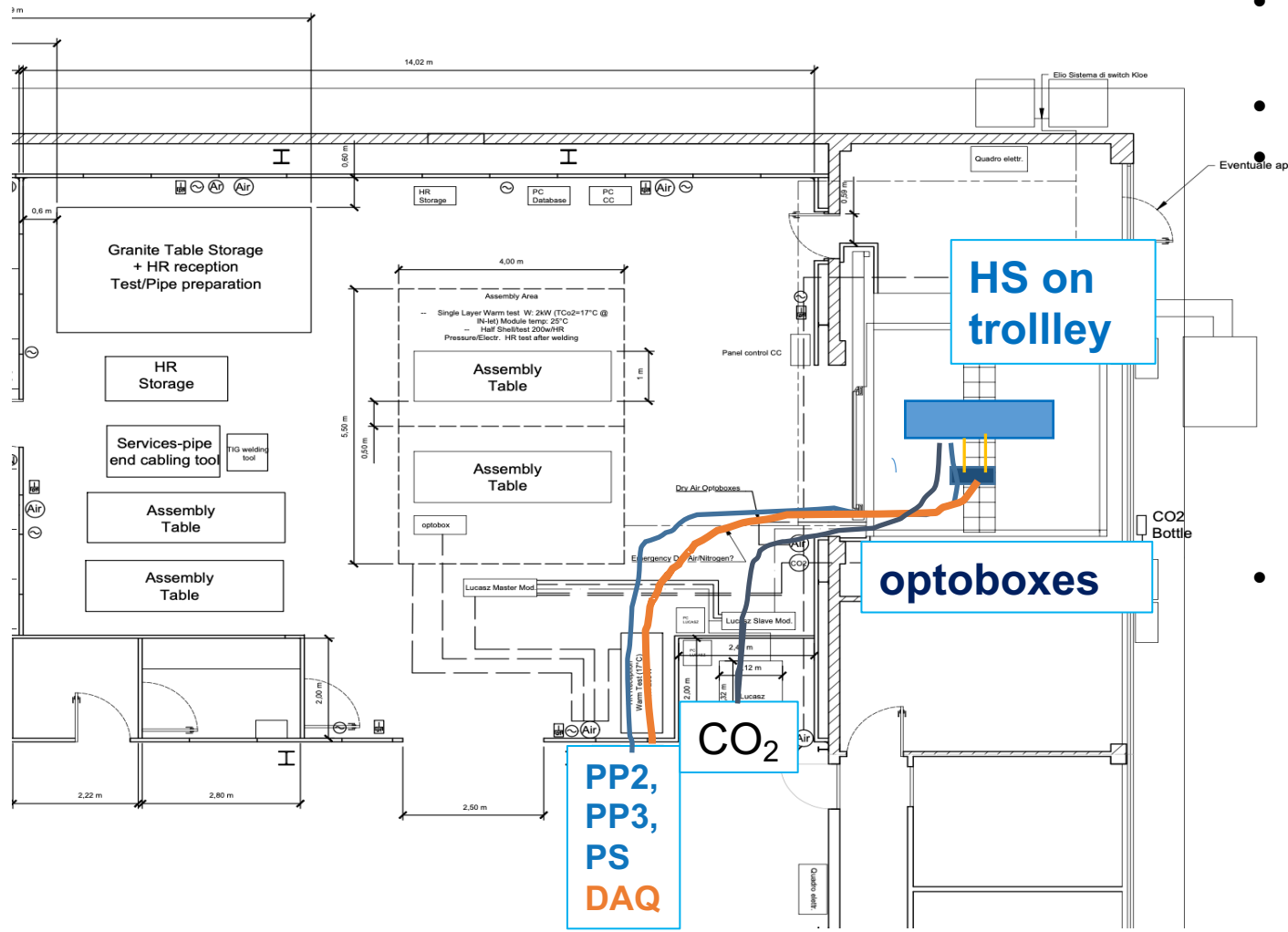
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# Functional and Connectivity test on populated HS with cold CO<sub>2</sub>

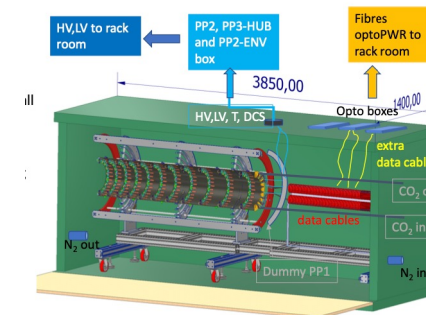
# Functional test on populated Half-Shell

Previous Step: connectivity of individual HRs with LP mode	Current Step: populated HS
Electrical and Data connectivity for each HR	<ul style="list-style-type: none"><li>• CO<sub>2</sub> Cooling</li><li>• GS cooling</li><li>• Overall connectivity at low T</li><li>• Thermal cycles</li><li>• Post-thermal cycle connectivity at low T</li></ul>

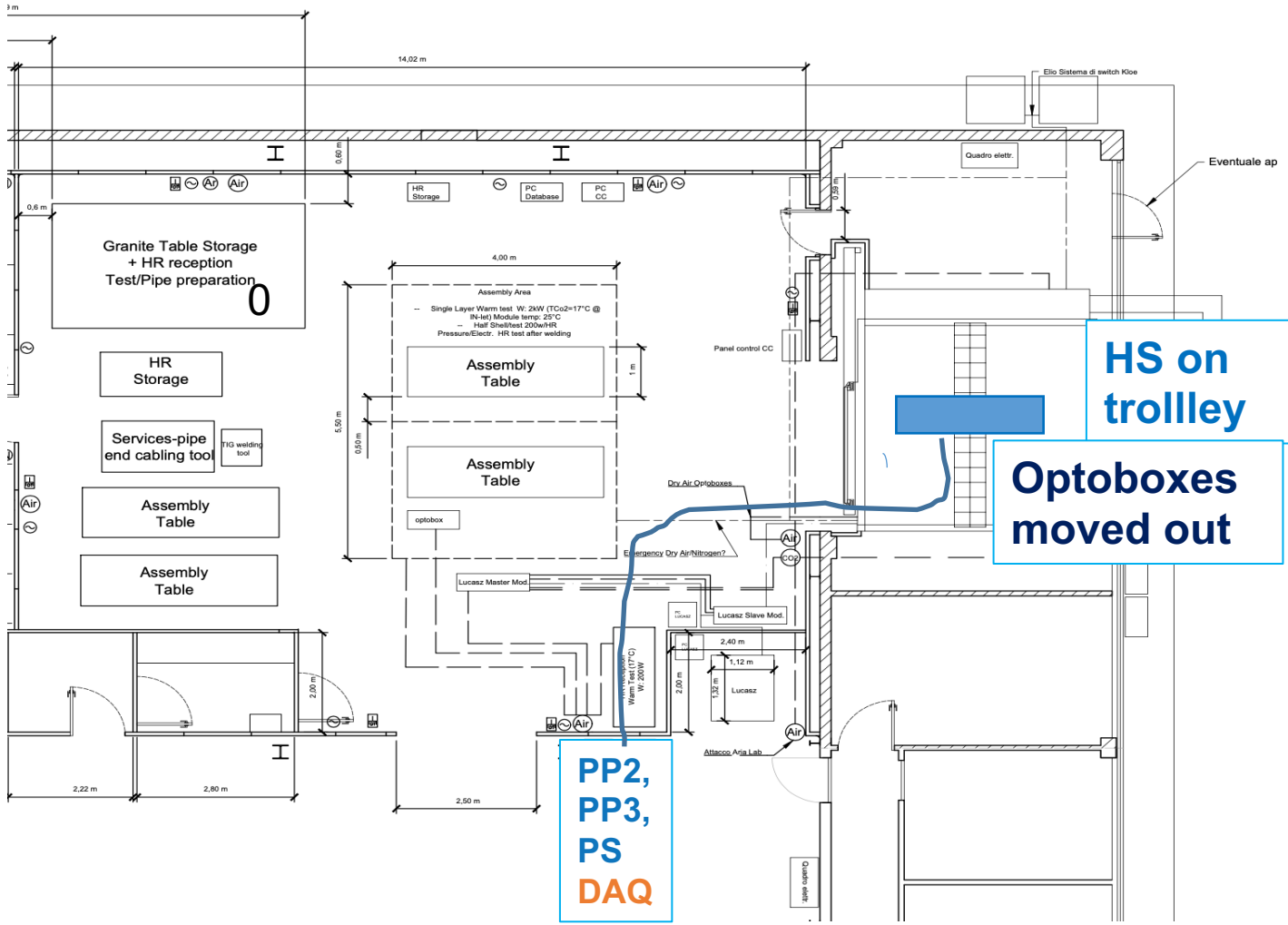
# Functional test on populated Half-Shell – pre thermal cycle



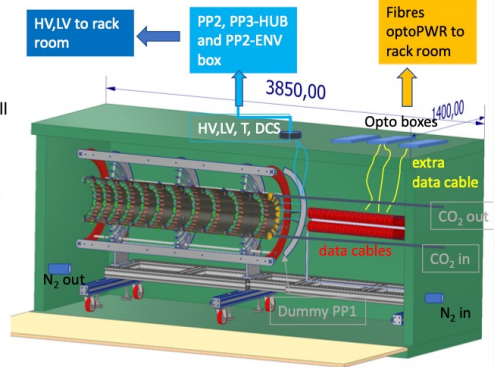
- Functional cold test with CO<sub>2</sub> at T<sub>ev</sub> ~ -15 C of populated HS
- DP < - 60 C
- Baseline: in Climate Chamber
  - T<sub>CC</sub> ~ +20C a
    - Could be lower to help cooling due to limited CO<sub>2</sub> flow from the plant
    - Bonus running at low T<sub>CC</sub>: easier to reach low DP and more precise measurement from viasala DP sensor
- All the services are connected up to PP<sub>2</sub> and PP<sub>3</sub>



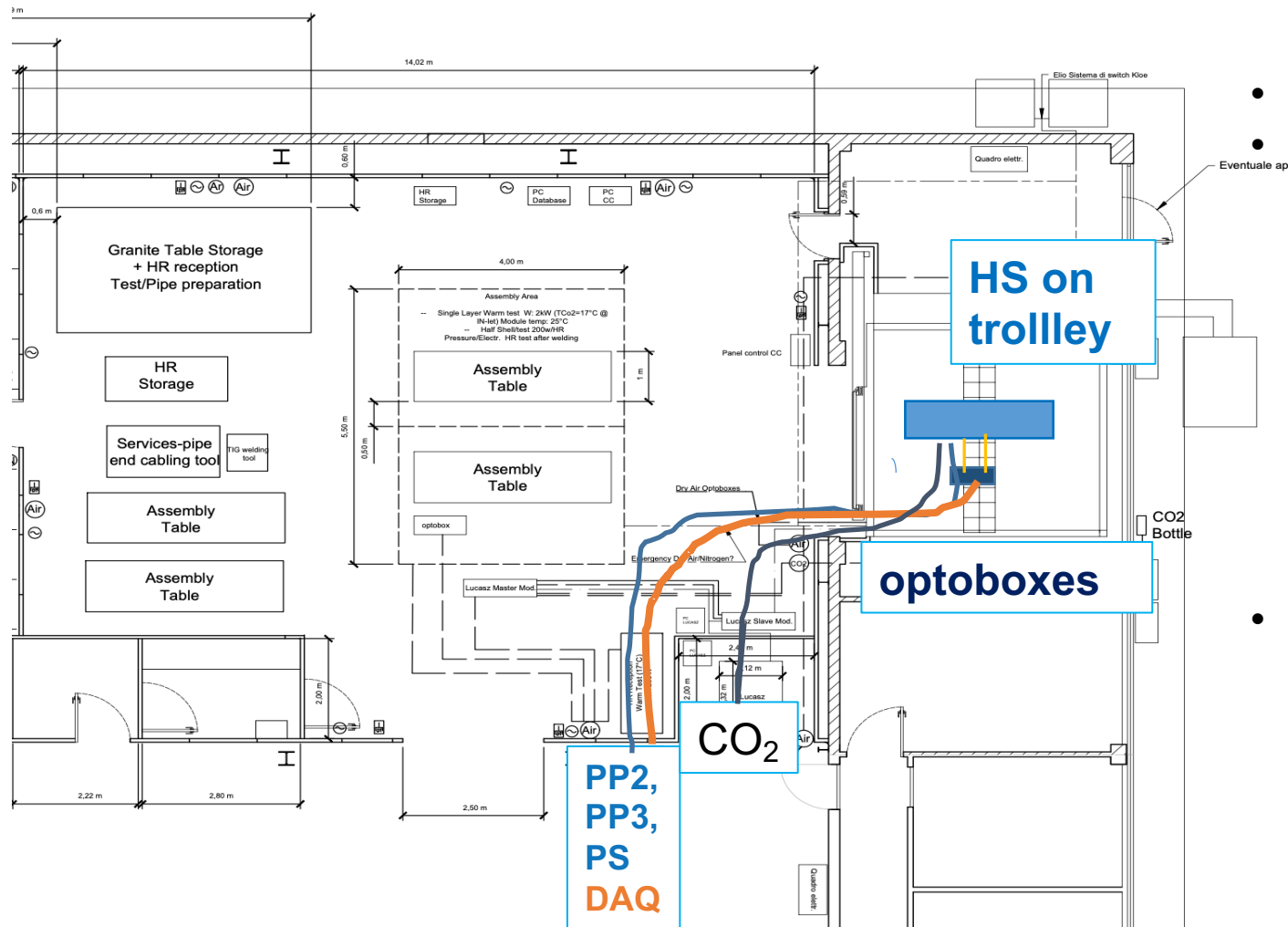
# Thermal Cycle populated Half-Shell



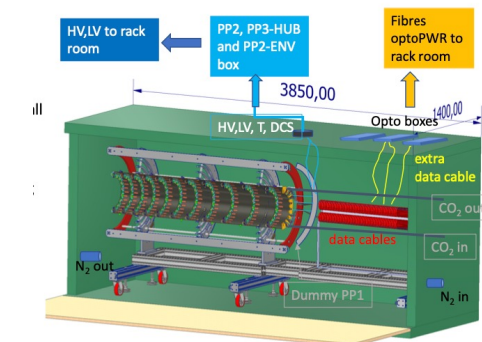
- Thermal cycle [+40 – 45C ] in the Climate Chamber with detector **off**
- DCS (box sensors) on
- Interlock (box sensors) on
- DP < -60 C
- Optoboard out



# Functional test on populated Half-Shell – post thermal cycle



- Functional cold test with CO<sub>2</sub> at  $T_{ev} \sim -15$  C of populated HS
- DP < - 60 C
- Baseline: in Climate Chamber
  - $T_{CC} \sim +20$ C a
    - Could be lower to help cooling due to limited CO<sub>2</sub> flow from the plant
    - Bonus running at low  $T_{CC}$ : easier to reach low DP and more precise measurement from viasala DP sensor
- All the services are connected up to PP<sub>2</sub> and PP<sub>3</sub>



# Equipment

Full equipment for EC integration in [ITkPixelIntegration-ElectrialEquipment-v10\\_docx\\_cpdf.pdf](#)

Table 2: Table of testing steps for one half-shell of layers 2, 3 and 4 of one EC.

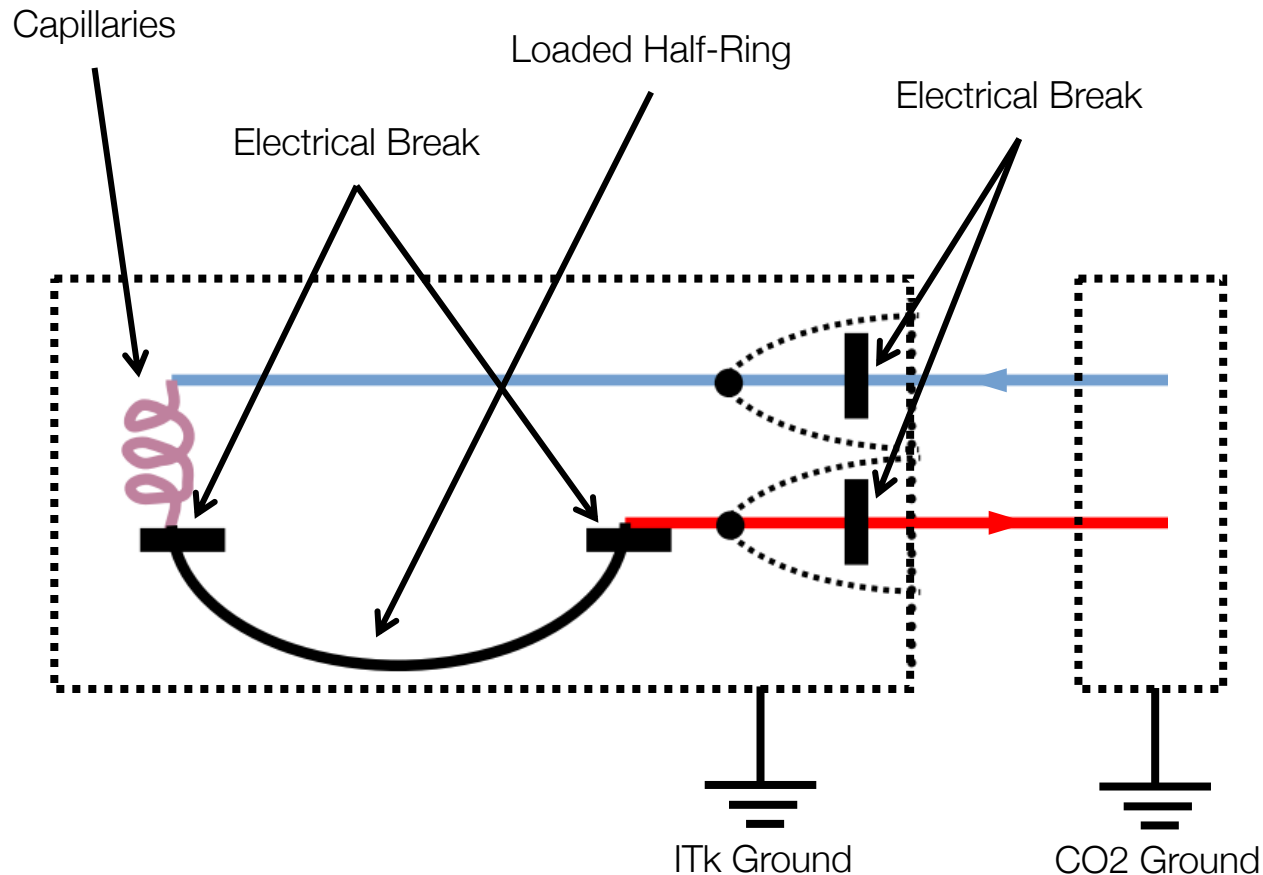
Test step	Detector Tested Section	Number of Serial Power Chains	Number Data (Up/Down) Links
1/6	5 HR L2 (0.5 link/FE) left/right	10	160/80
2/7	6 HR L2 (1 link/FE) left/right	12	384/96
3/8	8 HR L3 (0.5 link/FE) left/right	16	352/176
4/9	4 HR L4 (0.25 link/FE) left/right	8	104/104
5/10	5 HR L4 (0.5 link/FE) left/right	10	182/130

The largest testing step and thus required equipment is step 3.

- 4 PP1 connector, 4 type-2 cables,
- 1 Env-terminal PP1 connector (2 wire T-sensor), 1 Extra Env PP1 connector, 2 Env. Type-2 cable
- 2(4) LV(HV) PSU
- 32 twinax bundles, 3 trunk fibers
- ...

# Functional test on populated HS: G&S. Cooling scheme

- When testing with CO<sub>2</sub>, proper G&S scheme should be adopted



- Need EB between cooling transfer lines from lucasz plant and on-detector cooling pipes to reduce noise fr

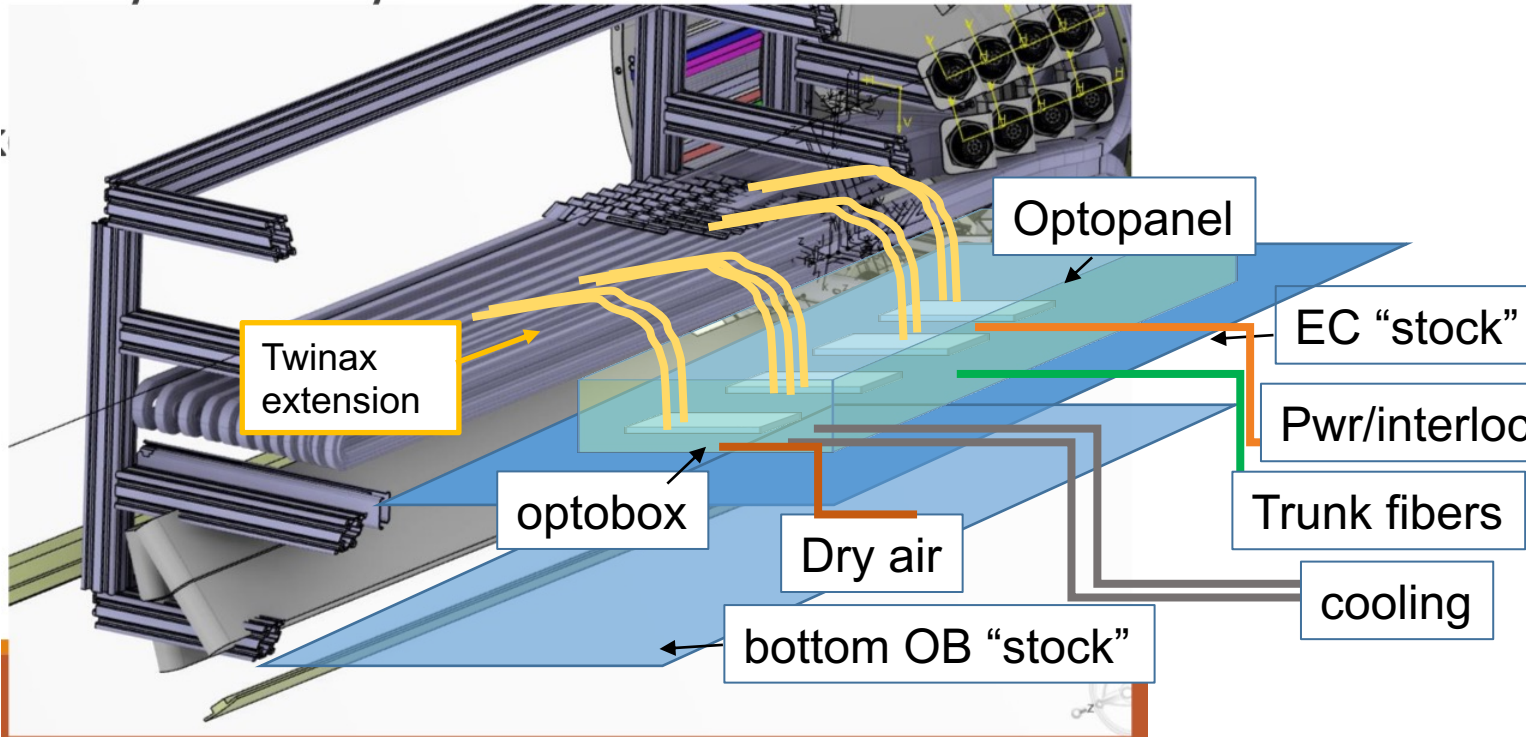
Details in Leonardo's slide

From [Slice Test in SR1](#)



# Trolley for Optopanel during integration / surface tests

O.Shea, S. Eisenhardt, E. Vigeolas

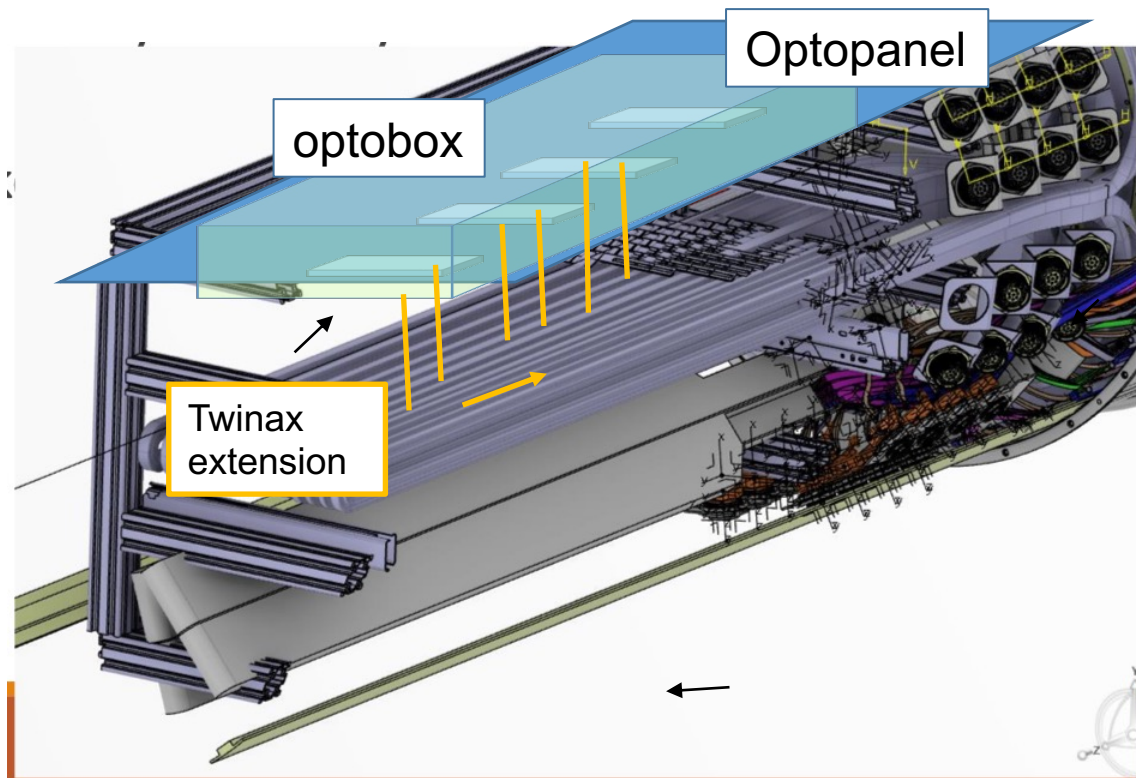


- As close as possible to the termination boards
    - twinax extension will be ~ 2m long, TBC if more.
  - Baseline geometry
    - 4 Optoboards s in one row
  - Movable
    - away during EC thermal cycle
  - Both for individual test of EC,OB and combined test
  - Optoboxes should be (de)mountable
    - Normal and Mirrored type
  - Preferably Inside the test box
    - less feedthroughs for trunk cable wrt twinax extensions
- Dimension of test box large enough

- Conceptual sketch; not in scale
- External inputs needed. Design of
  - optopanel and holding structures for data extension
  - Termination boards position and holding structures for data extension on trolley

# Trolley for Optopanel during EC testing

O.Shea, S. Eisenhardt, E. Vigeolas



Equipment:

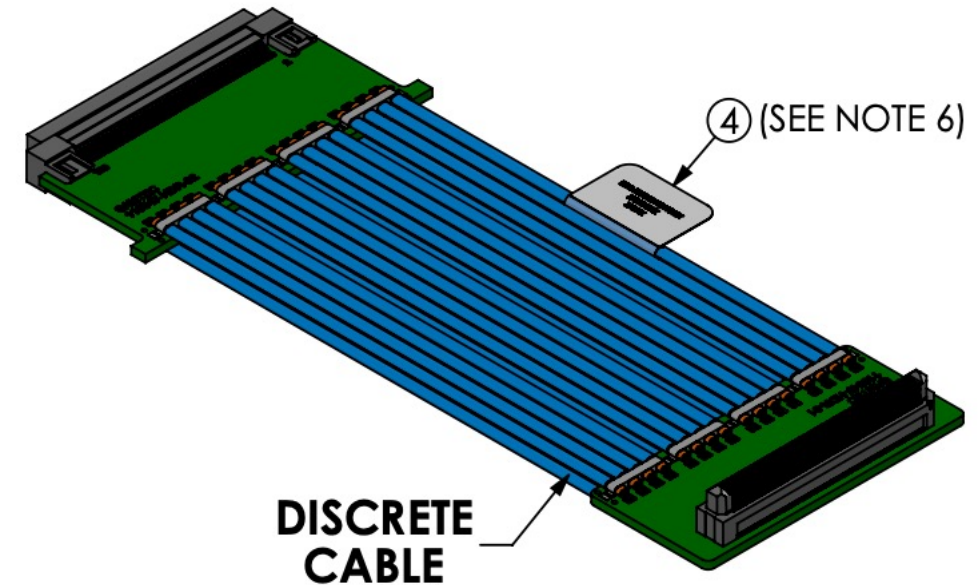
4(3) Type M(N) optoboxes , 4 type-2 Opto-MoPS cable, 7 type-2 Vopto cable, 3 trunk fibers,...

[ITkPixelIntegration-ElectrialEquipment-v10 docx cpdf.pdf](#)

- For EC to save space in the test box, possible to place the optopanel in the envelope for OB services
- We will get 4(3) Type M(N) optoboxes
- Possible to keep always Type M optoboxes if reconfigured software-wise for the test of different detector region
- G&S:
  - Finale System: shield around the twinax bundles to extended the faraday cage to optopanel
  - In integration side:
    - Optopanel in contact with the service trolley which has the ITk ground

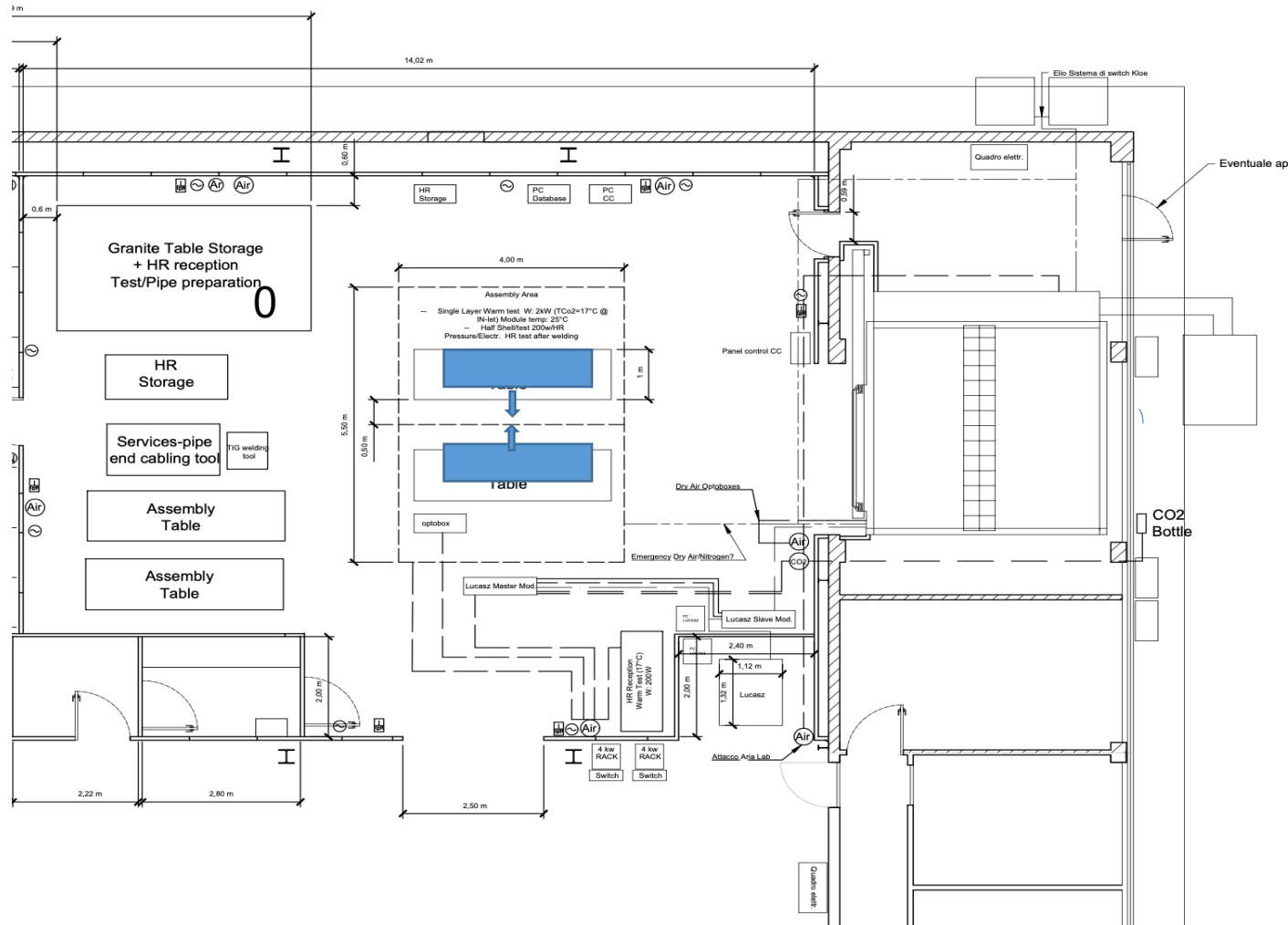
- Ordered 6x data extender prototypes for electrical test
  - 3x 2m, 3x 3m

- Prototypes expected in ~2months

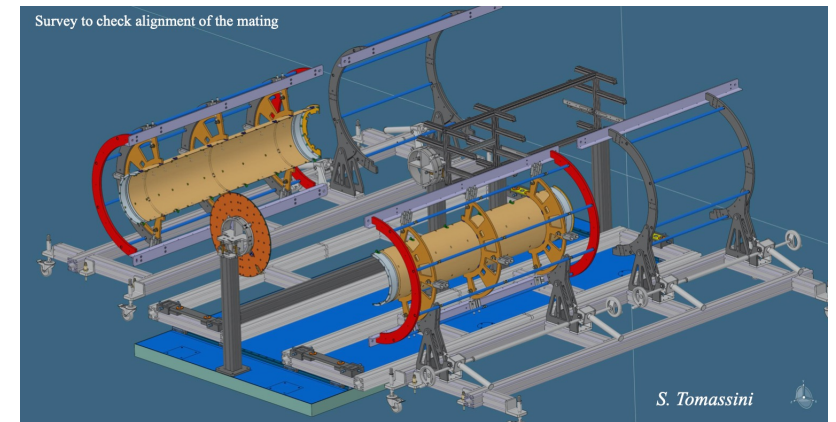


- Mechanical aspects are still to be evaluated:
  - the definition of the termination boards position and orientation on trolley are not available

# Mating of Half-shell

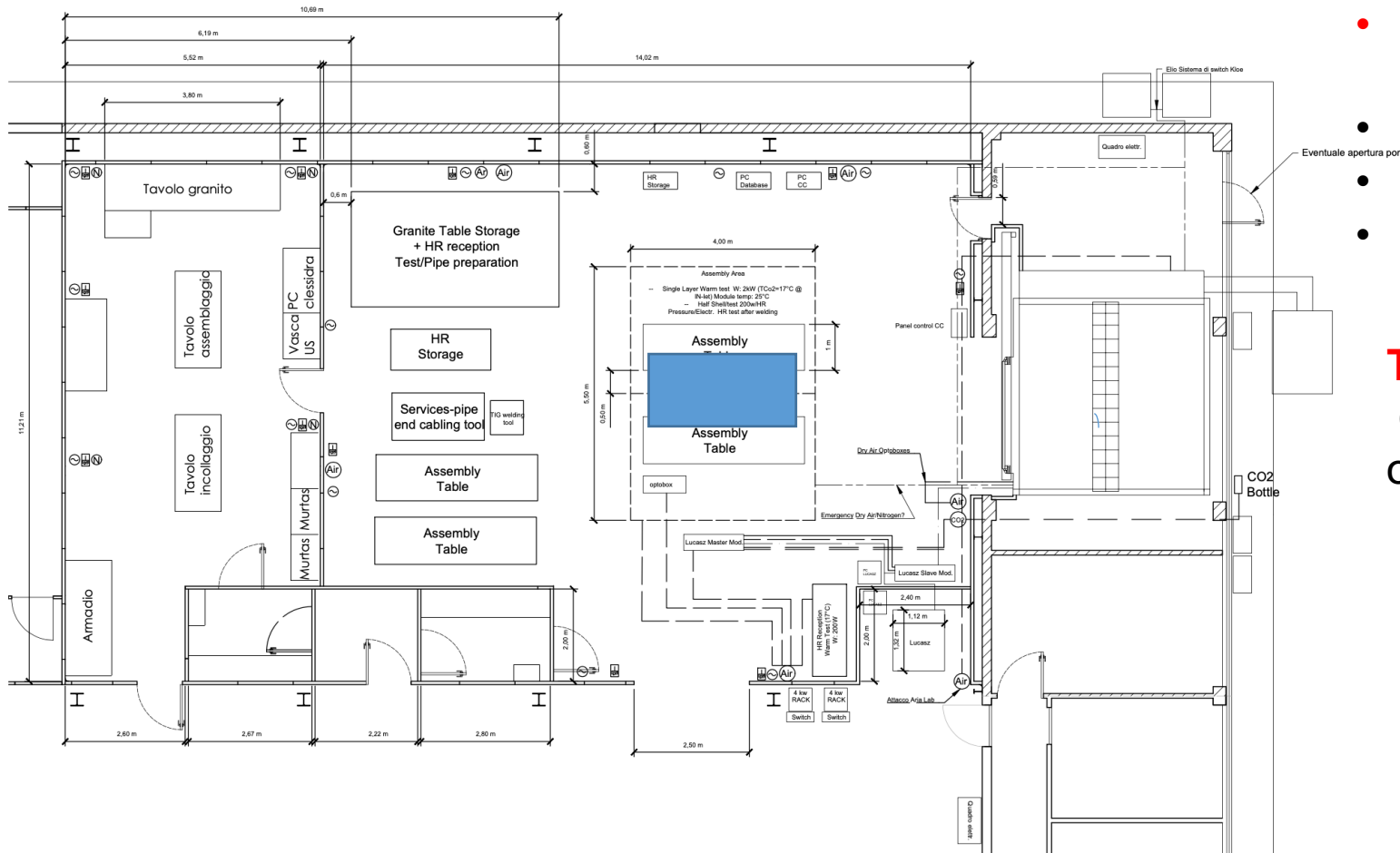


- Move the trolley in mating area
- Redo operation for the twin HS
- Mating couple of half-shells to form a layer
- Check alignment with laser track



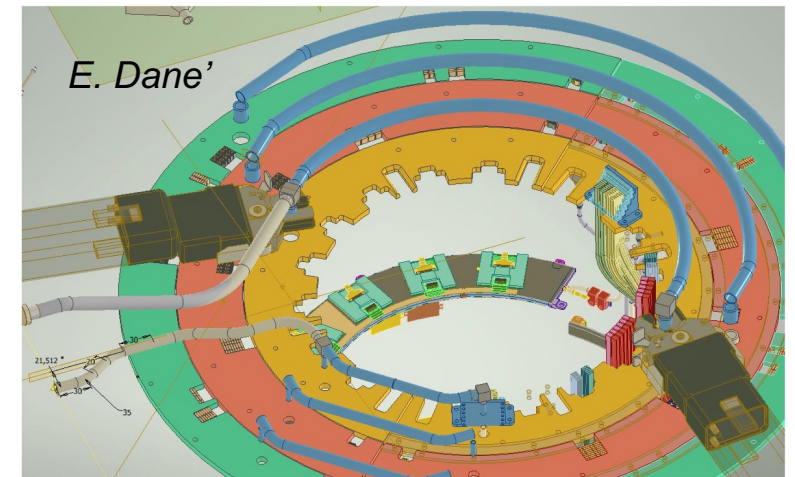
Now the structure is almost **closed**  
 ( small holes on low Z flange )  
 Convection cooling not enough

# Complete layer ready



- Move trolley in the mating area
- **Weld the manifolds of the individual HS here**
- Leak test
- Pressure test 162 bar
- Leak test

**TBD:** connectivitt tests before or after (preferred) welding welding of manifolds?



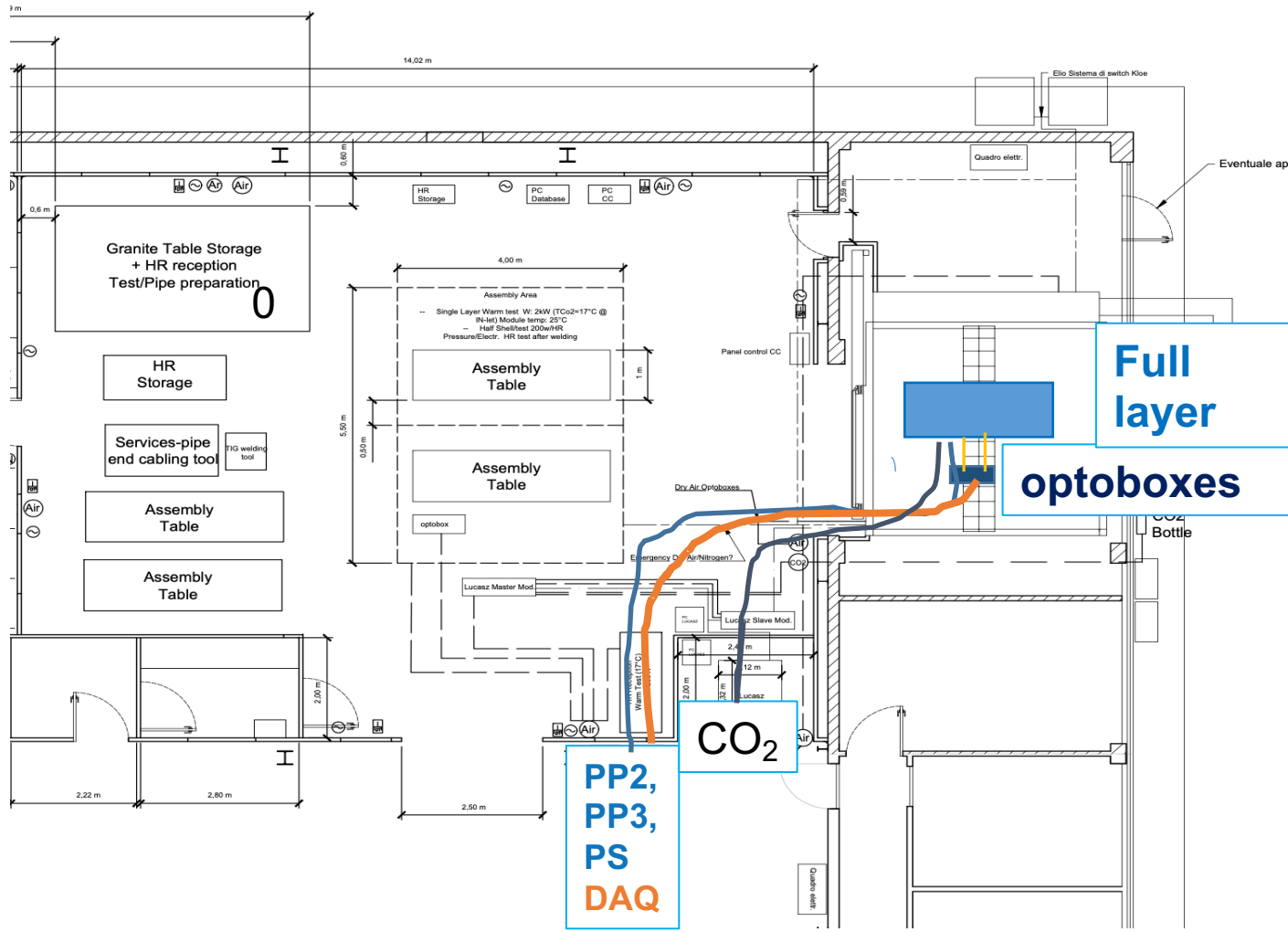
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# Connectivity test on complete layer

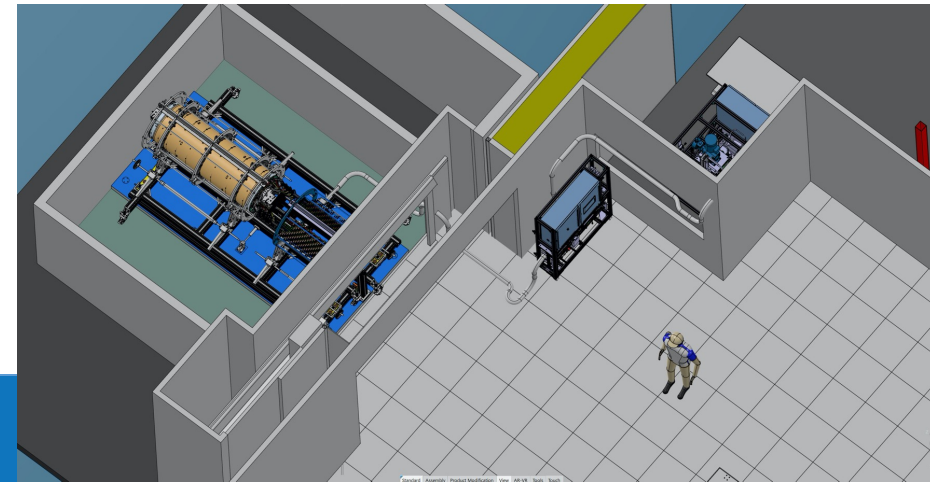
# Connectivity test on completed layers

Previous Step: tests on HS	To be tested	How?
<ul style="list-style-type: none"><li>• Overall connectivity at low T pre and after thermal cycle on individual HS</li><li>• CO<sub>2</sub> Cooling</li></ul>	Connectivity of complete layer after mating	<p><b>Pending:</b></p> <ul style="list-style-type: none"><li>• tests before or after (preferred) welding of manifolds</li><li>• <b>Granularity</b> same as for individual HS</li><li>• <b>Cooling options</b><ul style="list-style-type: none"><li>• Low pow mode in climate chamber</li><li>• Nominal (Small) flux CO<sub>2</sub> + low power mode if manifolds are not ( are) welded</li><li>• Nominal (Small) flux CO<sub>2</sub> + low power mode in climate chamber if manifolds are not ( are) welded</li></ul></li></ul> <p><b>Test:</b></p> <ul style="list-style-type: none"><li>• Short connectivity test: configure one module per SP chain all return data lines with digital scan or electrical&amp;optical alignment</li></ul>

# Connectivity test on complete layer



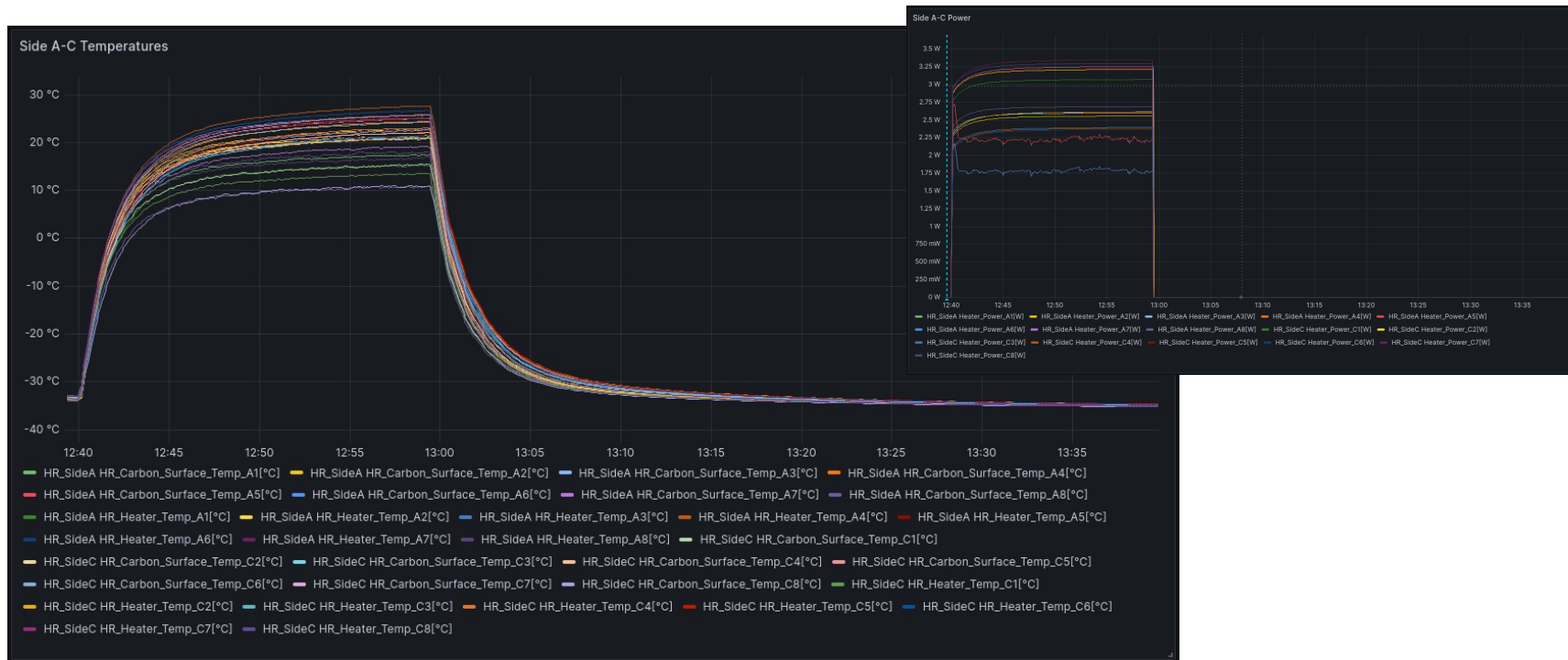
- Baseline:
  - Move the trolley with the complete layer the climate chamber
- Cooling options:
  1. with CO<sub>2</sub> at  $T_{ev} \sim +15\text{ C}$
  2. Low power mode in climate chamber
  3. Both CO<sub>2</sub> and Low power mode
- *In both cases: temperature inside climate chamber could be lowered to help cooling*
- DP < -60 C if CO<sub>2</sub> running
- Bonus running at low T<sub>CC</sub>:  
easier to reach low DP and more precise measurement from viasala DP sensor





# Test on Thermal HR in small climate chamber

- Preliminary, work in progress
- Rough enclosure to emulate low air conduction regime



Further tests will come with CO<sub>2</sub> flux (\*) and correlation with environment T

(\*) Thanks to Ian, Jo, Alex, Paki for providing us the Fred-fittings!

Z. Chubinidze, B. Buadze

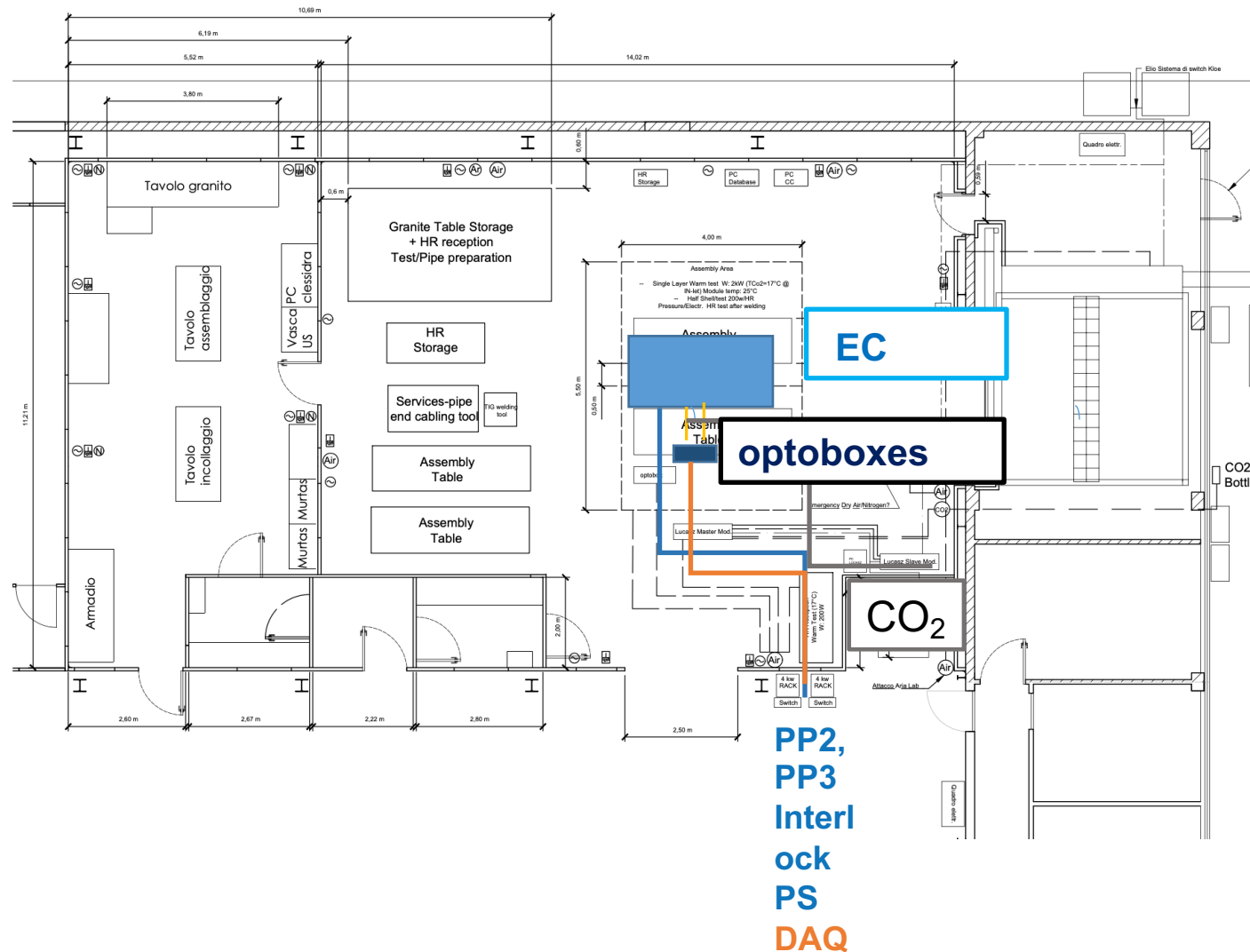
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# Connectivity test on complete endcap

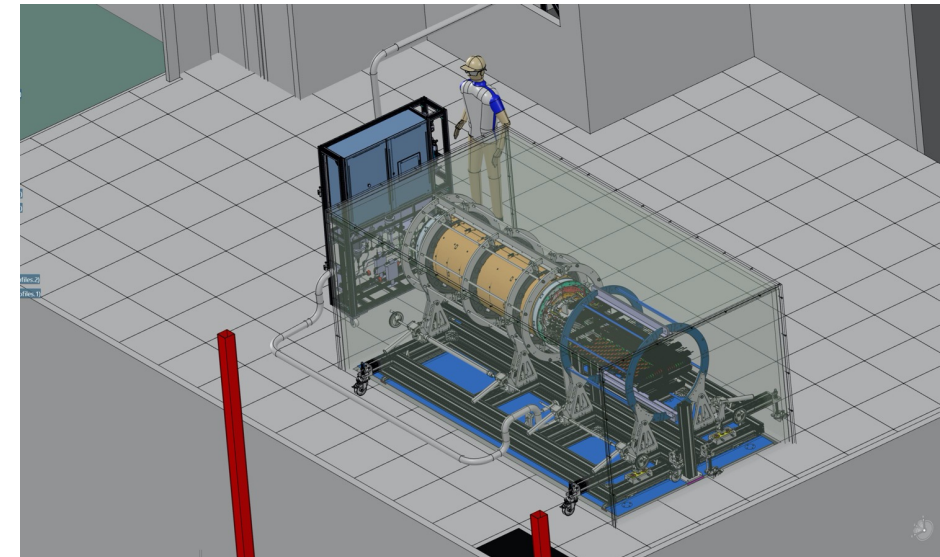
# Connectivity test on complete endcap

Already checked in previous steps	To be tested	How
<p>Overall connectivity</p> <ul style="list-style-type: none"> <li>• For HS at low T CO<sub>2</sub></li> <li>• For completed layer at high T CO<sub>2</sub> and/or LP mode</li> </ul>	<ul style="list-style-type: none"> <li>• Full endcap connectivity</li> <li>• Final Commissioning Test</li> <li>• Reference for SR1 post-shipment test</li> </ul>	<p><b>Granularity</b> same as for individual HS</p> <p><b>Where:</b> TBD in shipping box or climate chamber</p> <p><b>Cooling options</b></p> <ul style="list-style-type: none"> <li>• Low pow mode in climate chamber</li> <li>• Small flux CO<sub>2</sub> + low power mode</li> <li>• Small flux CO<sub>2</sub> + low power mode in climate chamber</li> </ul> <p><b>Test:</b></p> <ul style="list-style-type: none"> <li>• Short connectivity test: configure one module per SP chain all return data lines with digital scan or electrical&amp;optical alignment</li> </ul>

# Completed Endcap



- All manifolds are welded → CO<sub>2</sub> flux reduced by 2
- Final reference warm test to be compared with reception test at SR1
- **Cooling Options**
  - Low pow mode in climate chamber
  - Small flux CO<sub>2</sub> + low power mode
  - Small flux CO<sub>2</sub> + low power mode in climate chamber



# Reception Test at SR1

[ITkPixelIntegration-ElectrialEquipment-v10\\_docx\\_cpdf.pdf](#)

- Same Testing step and
- Same Equipment used in Integration site

*Table 2: Table of testing steps for one half-shell of layers 2, 3 and 4 of one EC.*

Test step	Detector Tested Section	Number of Serial Power Chains	Number Data (Up/Down) Links
1/6	5 HR L2 (0.5 link/FE) left/right	10	160/80
2/7	6 HR L2 (1 link/FE) left/right	12	384/96
3/8	8 HR L3 (0.5 link/FE) left/right	16	352/176
4/9	4 HR L4 (0.25 link/FE) left/right	8	104/104
5/10	5 HR L4 (0.5 link/FE) left/right	10	182/130

- At SR1 no cooling limitation
- We may have a test with CO2 there instead of a LP mode for the final tests in integration site

# Backup

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# Test on Thermal HR in small climate chamber

- Preliminary, work in progress
- Rough enclosure to emulate low air conduction regime



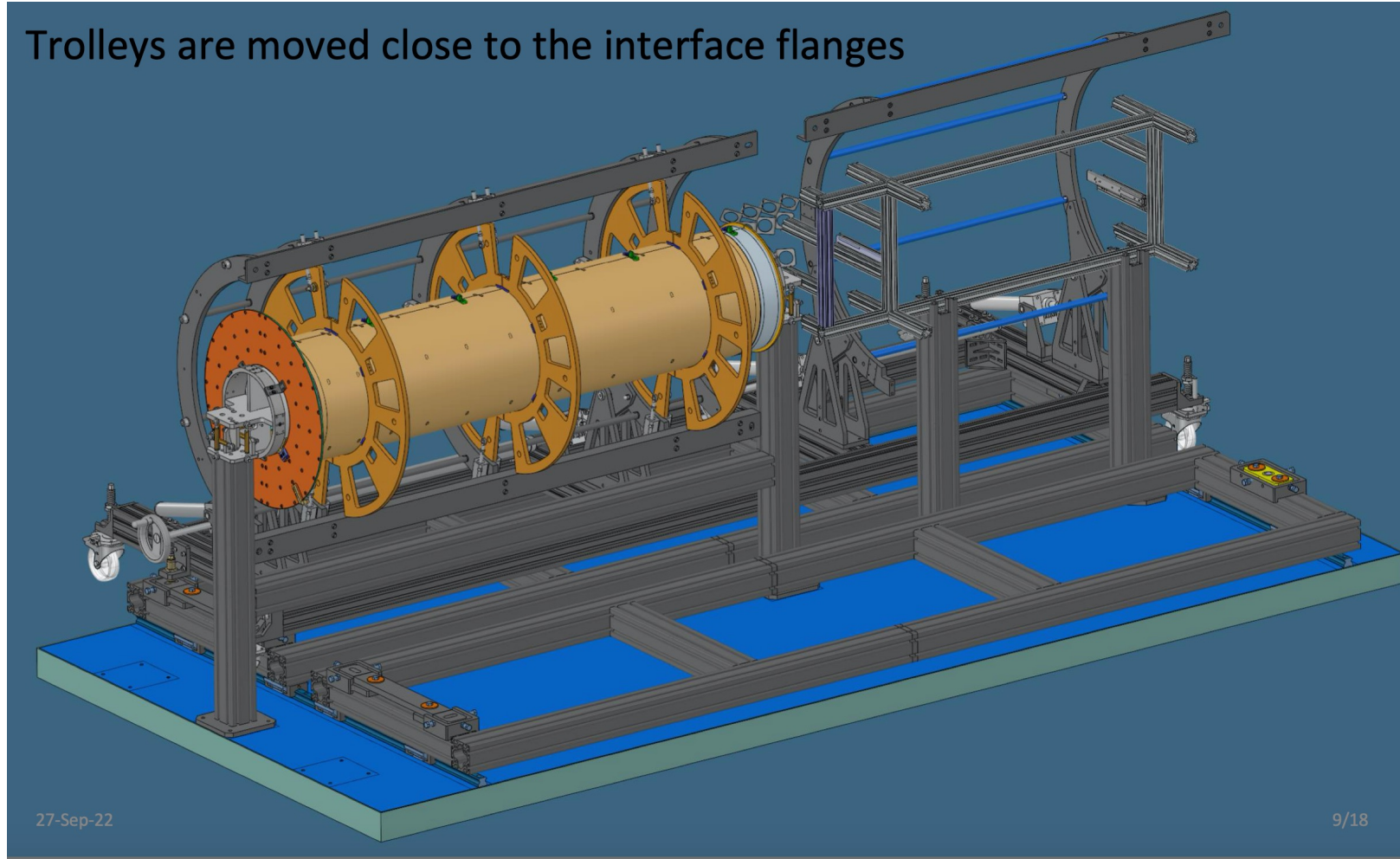
Further tests will come with CO2 flux



Z. Chubinidze, B. Buadze

# HS and tooling preparation - 4

Trolleys are moved close to the interface flanges



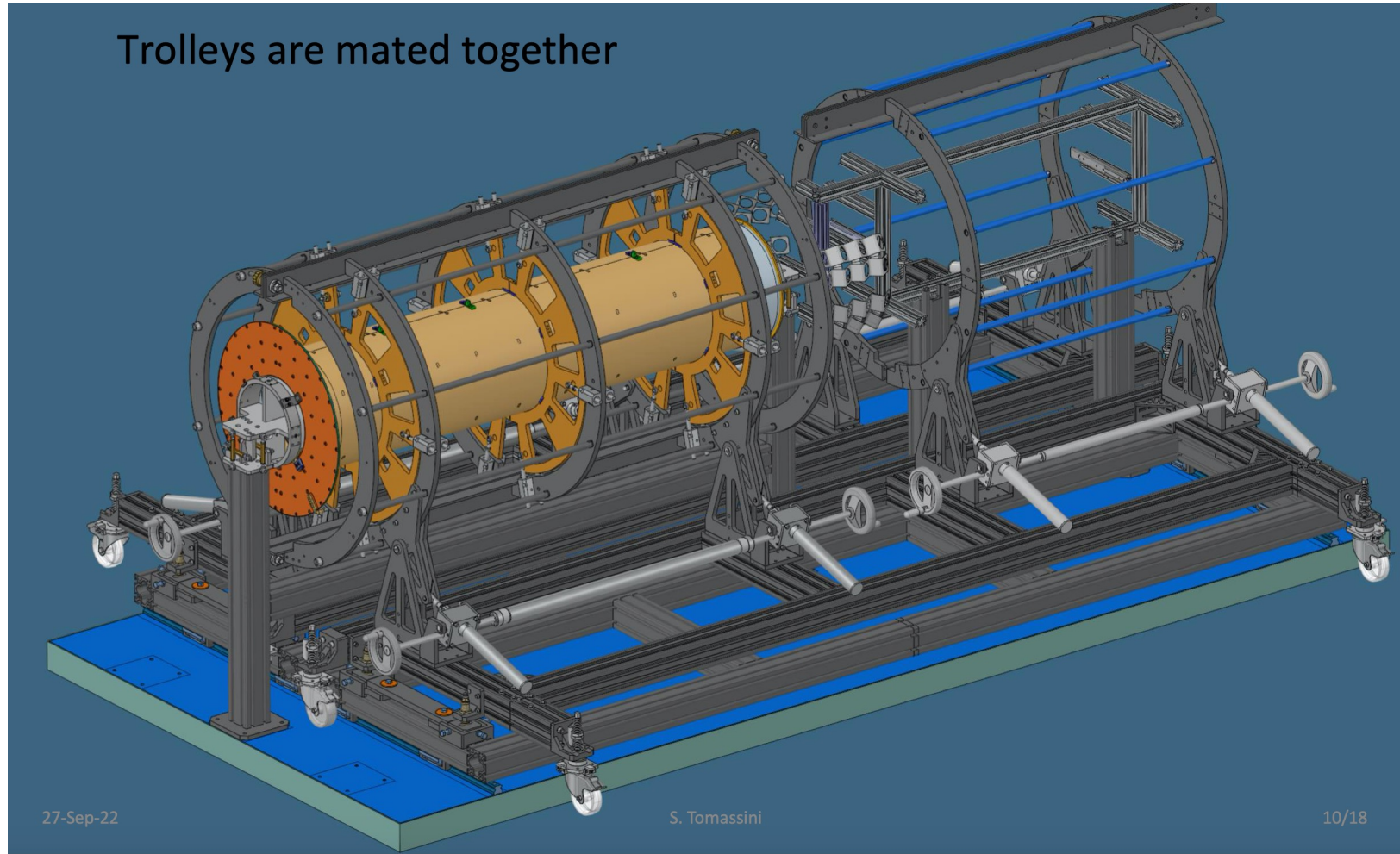
[GM | Tomassini 27Nov2022 talk](#)



# HS and tooling preparation - 6

[GM I Tomassini 27Nov2022 talk](#)

Trolleys are mated together

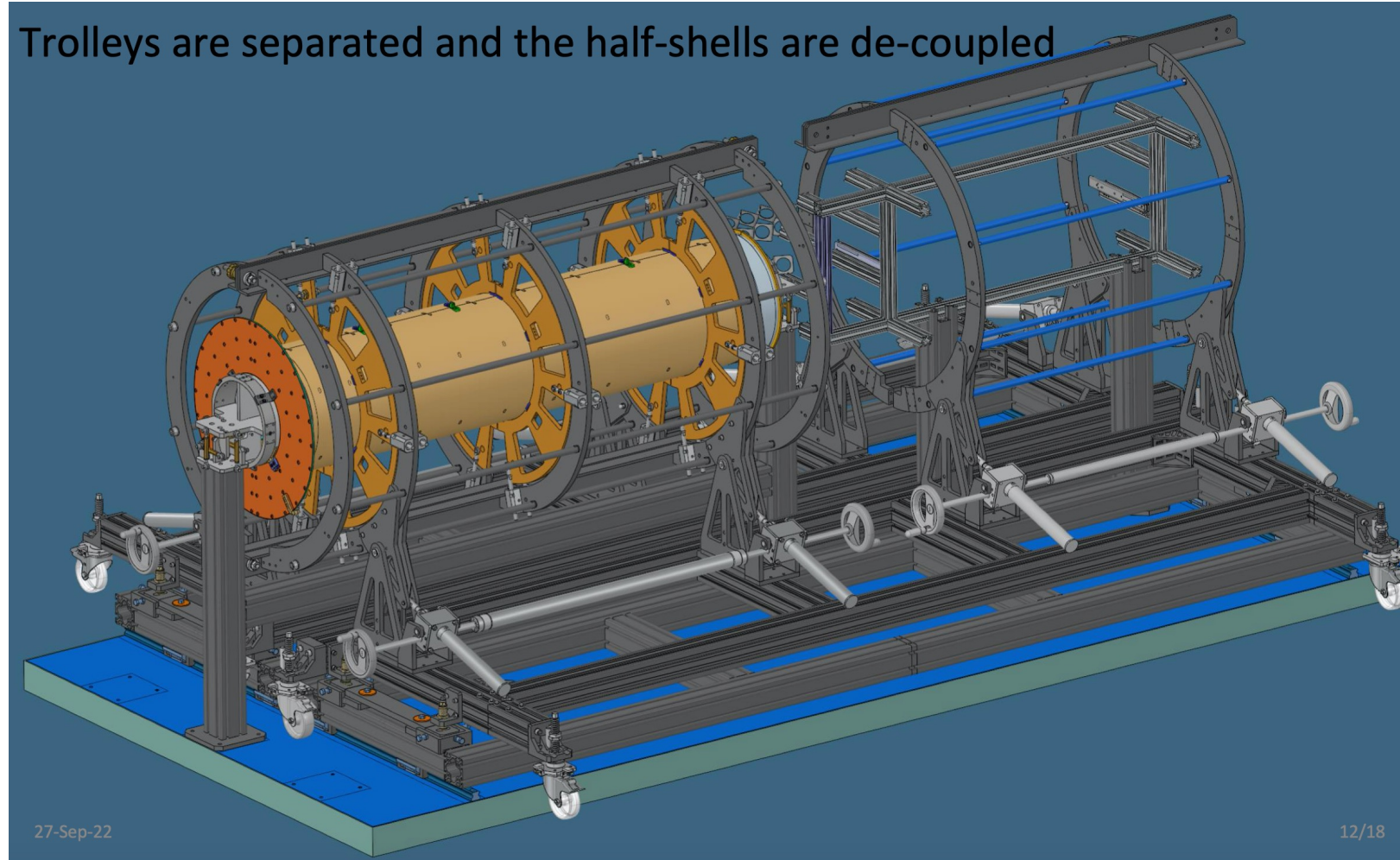


27-Sep-22

S. Tomassini

10/18

# HS and tooling preparation - 8



GM | Tomassini 27Nov2022 talk

# Mating of Half-shell

FARO Laser Tracker Vantage:  
Measurement of the target position  
(contact measurement)



## Point to Point Accuracy\*\*\*

In-Line Distance Measurement								
Length	2-5m (6.6-16.4ft)	2-10m (6.6-32.8ft)	2-20m (6.6-65.6ft)	2-30m (6.6-98.4ft)	2-40m (6.6-131.2ft)	2-60m (6.6-196.9ft)	2-80*m (6.6-262.5ft)	
Distance	3m (9.8ft)	8m (26.2ft)	18m (59ft)	28m (91.9ft)	38m (124.7ft)	58m (190.3ft)	78m (255.9ft)	
ADM	MPE	0.018mm (0.0007")	0.022mm (0.0009")	0.030mm (0.0012")	0.038mm (0.0015")	0.046mm (0.0018")	0.062mm (0.0025")	0.078mm (0.0031")
	Typical	0.009mm (0.0004")	0.011mm (0.0004")	0.015mm (0.0006")	0.019mm (0.0008")	0.023mm (0.0009")	0.031mm (0.0012")	0.039mm (0.0015")



Horizontal Scale Bar Measurement (2.3m, 7.55ft)									
Range	2m (6.6ft)	5m (16.4ft)	10m (32.8ft)	20m (65.6ft)	30m (98.4ft)	40m (131.2ft)	60m (196.9ft)	80*m (262.5ft)	
ADM	MPE	0.044mm (0.0017")	0.064mm (0.0025")	0.099mm (0.0039")	0.170mm (0.0067")	0.240mm (0.0095")	0.311mm (0.0122")	0.453mm (0.0178")	0.594mm (0.0234")
	Typical	0.022mm (0.0009")	0.032mm (0.0013")	0.049mm (0.0019")	0.085mm (0.0033")	0.120mm (0.0047")	0.156mm (0.0061")	0.226mm (0.0089")	0.297mm (0.0117")

\*With selected targets. \*\*Product complies with radiation performance standards under the food, drug, and cosmetics act and international standard IEC 60825-1:2001-08. \*\*\*MPE and all accuracy specifications are calculated per ASME B89.4.19-2006. Variation in air temperature is not included. Specifications, descriptions, and technical data may be subject to change. \*\*\*\*With integrated weather station. Protected by U.S. patents: 7,327,446 7,352,446 7,466,401 7,701,559 8,040,525 8,120,780

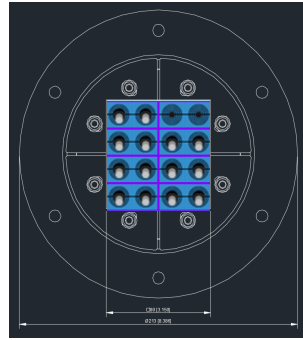
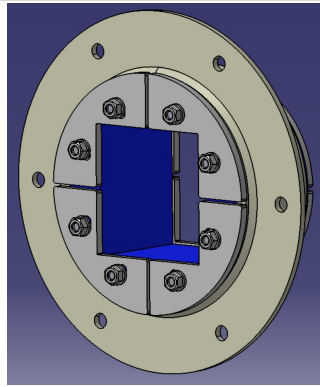
# Status of datase extenders extension

---

- Ordered 6x data extender prototypes for electrical test
  - 3x 2m, 3x 3m
- Prototypes expected in ~2months
- Mechanical aspects are still to be evaluated:
  - the definition of the termination boards position and orientation on trolley are not available
  - Tehcnical design and mapping in backup slides

# Feedthrough Options

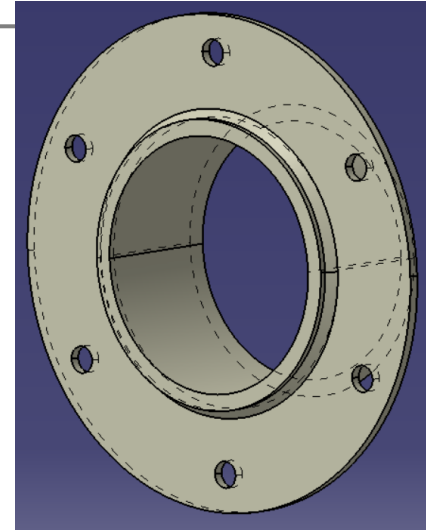
(1)



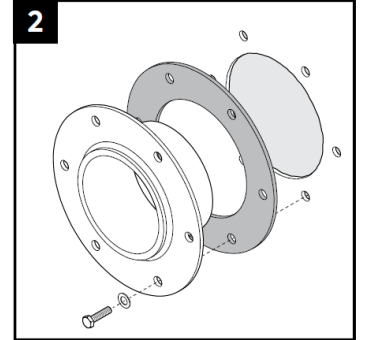
Optoboxes

- AISI316
- Packing space (mm) 80 x 80
- Aperture dimension Ø (mm) 144 - 144
- Weight (kg) 3.4

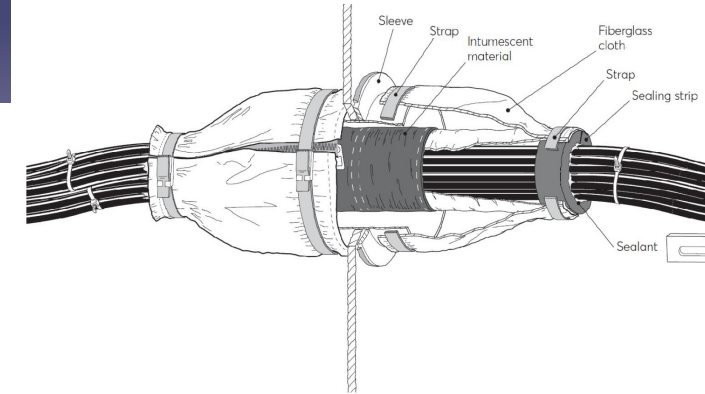
(2)



Sleeve gasket

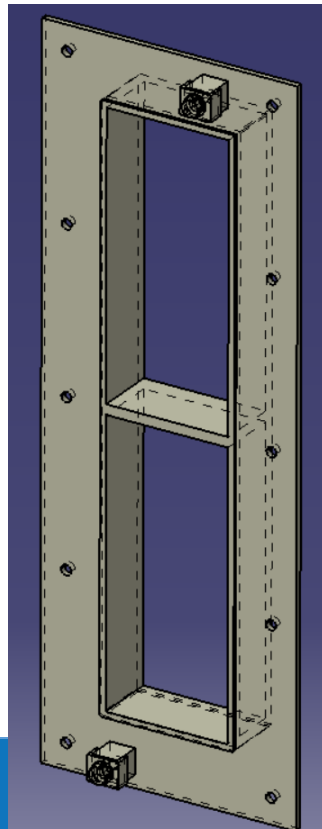


Round sleeve with pre-punched gasket.



Lighter (AISI316 1.6 kg)- to be used for sensor cables, for Type II ones and for those of the optoboxes (multiplicity to be defined)

- AISI316
- Frame openings 2
- Packing space (mm) 120 x 240
- External dimensions WxHxD (mm) 252.5 x 698 x 93
- Aperture dimensions WxH (mm) 148(+5/-5) x 595(+5/-5)
- Weight (kg) 9.8

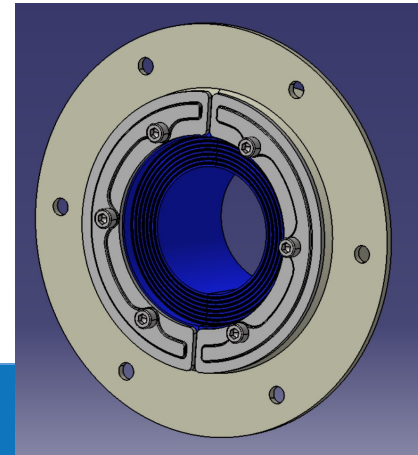


Sensors

Type II

CO<sub>2</sub>

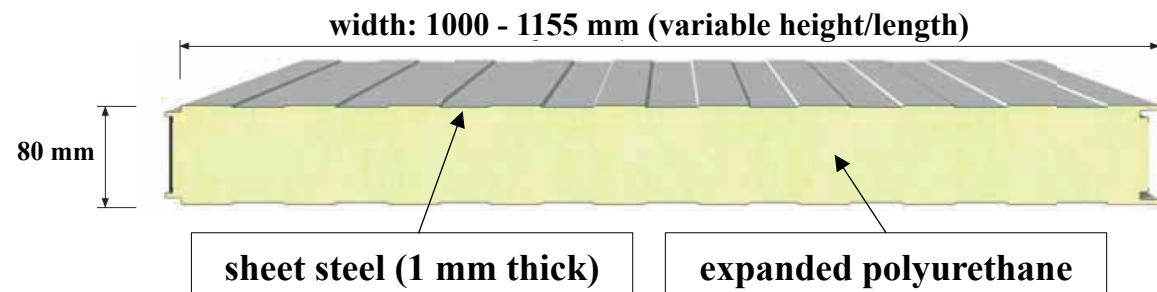
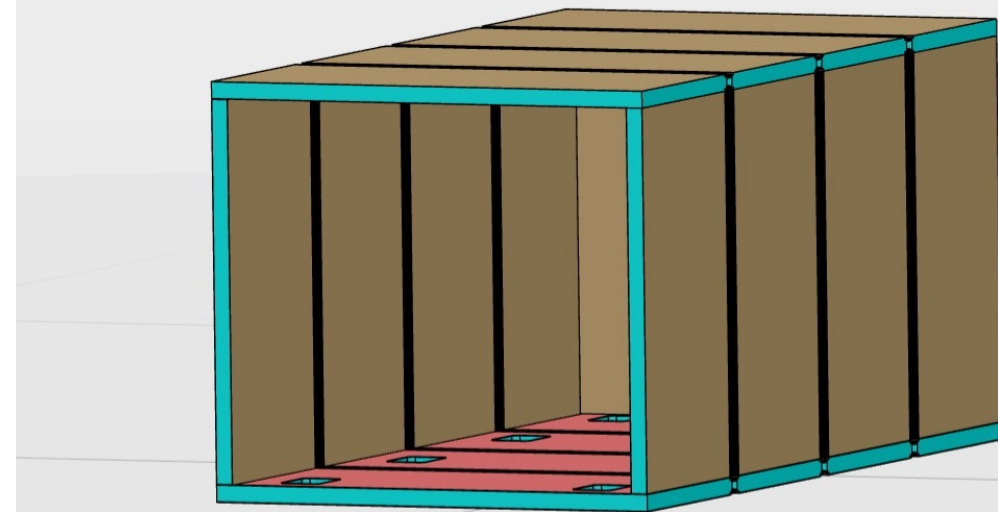
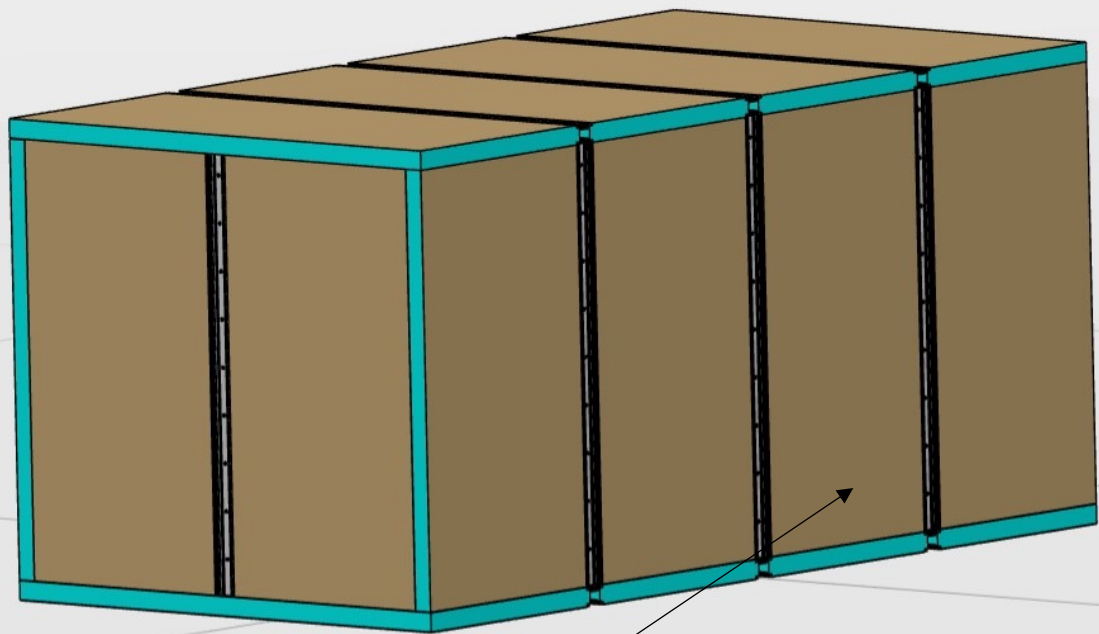
N<sub>2</sub> emergency



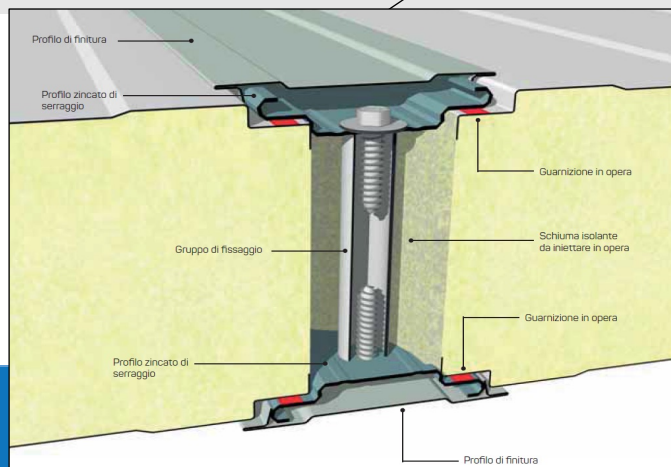
Feedthrough for single CO<sub>2</sub> line (AISI316 – Φ 66-98 mm – 3.6 kg)

# Reception Test and Transport Box

- Preliminary design: L x W x H = 4250 mm x 2200 mm x 2000 mm
- To be checked: space for optopanel trolley
- Note: The width of the door in SR1 is slightly more than 3000mm



A. Croce,  
G. Cesarini



Injected joint with insulating foam to be injected on site  
(Average Thermal Transmittance  $U = 0.119 \text{ W/m}^2\text{K}$ )

<b>Nominal Panel Thickness mm</b>	100	120	150	200
<b>Thermal Transmittance U (W/m<sup>2</sup>K)</b>	0.22	0.18	0.15	0.11

Annex A.10 of the European standard EN 14509

# Test of pwr bundles on trolley

4) harness dressing on EC/trolley jig:						
routing & fixation on loom:						
mounting of EoS connectors						
cable routing within EC, with CTE expansion loops						
cable routing around EC endflange						
cable looming between endflange and PP1 (to remain after assembly)						
cable routing towards trolley & storage/coiling of excess cabling						
PP1 connector mounting/adjustment (in extended trolley position)						
test of transition of trolley configuration between expanded and retracted position						
5) post dressing QC testing:						
connection of non-data cables (both sides)						
non-data cable harness connectivity test (LV)						
disconnection of non-data cables (both sides)						
analysis / QC decision & documentation non-data cables						

Stolen from S. Eisenhardt harnesses timeline

# Test of env. bundles on trolley

Stolen from S. Eisenhardt harnesses timeline

4) harness dressing on EC/trolley jig:					
	routing & fixation on loom:				
		mounting of volume T-sensors (2-wire)			
		cable routing within EC, with CTE expansion loops			
		cable routing around EC endflange			
		(transport compatible) mounting of cooling loop T-sensors (2-wire)			
		cable routing within EC, with CTE expansion loops			
		cable routing around EC endflange			
		(transport compatible) mounting of manifold T-sensors (2-wire & 4-wire)			
		cable routing around EC endflange			
		cable looming between endflange and PP1 (to remain after assembly)			
		cable routing towards trolley & storage/coiling of excess cabling			
		PP1 connector mounting/adjustment (in extended trolley position)			
		test of transition of trolley configuration between expanded and retracted position			
5) post dressing QC testing:					
		connection of env cables (PP1 side)			
		non-data cable harness connectivity test (LV)			
		disconnection of env cables (PP1 side)			
		analysis / QC decision & documentation env cables			

Cooling temperature and environmental sensors are installed. Electrical connectivity tests will be made to ensure that those sensors and their associated cabling are free from damage. Localized heat input / ‘cold-spray’ will be used to make sure the sensors respond appropriately (need to understand how best to check humidity sensors).



# Test of data bundles on trolley

4) harness dressing on EC/trolley jig:					
	routing & fixation on loom:				
	mounting of data pigtail connectors				
	cable routing withing EC, with CTE expansion loops				
	cable routing around EC endflange				
	cable looming between endflange and PP1 (to remain after assembly)				
	cable routing towards trolley & storage/coiling of excess cabling				
	optoboard adaptor mounting/adjustment (in extended trolley position)				
	test of transition of trolley configuration between expanded and retracted position				
5) post dressing QC testing:					
	connection of data cables (both sides)				
	data cable harness connectivity test (CON)				
	disconnection of data cables (both sides)				
	analysis / QC decision & documentation data cables				

Stolen from S. Eisenhardt harnesses timeline

# Infrastructures at LNF for EC Integration



Dryer -70C dew point



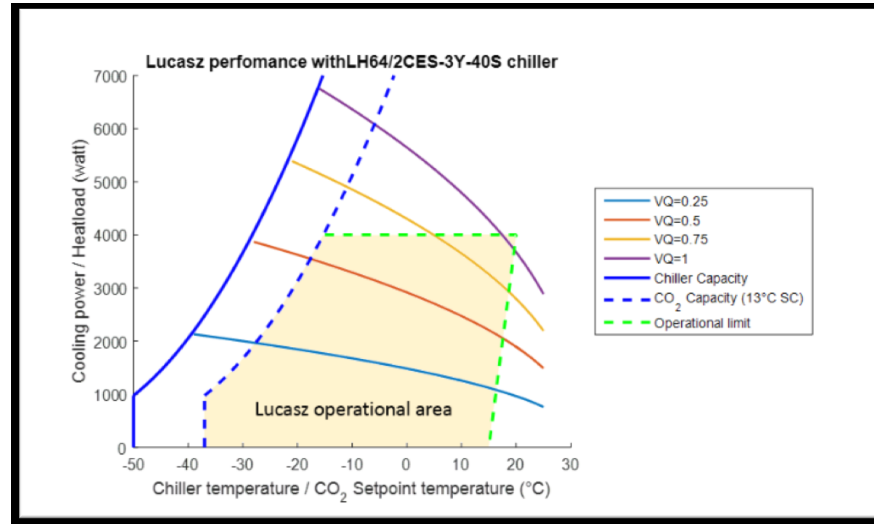
Climate Chamber functional  
To do: Need feedthrough for cables  
and CO<sub>2</sub> lines



CO<sub>2</sub> Lucasz commissioned plant a LNF  
To do : Merging of lines from master  
and slave boxes to reach 20 g/s

Start point inside Test Box	End point Outside TB	Type	Quantity	Dimensions (mm)
Optoboxes (4)	Small H <sub>2</sub> O cooling plant	Cooling pipes	2	8 / 10
	Rack: Felix board	Trunk fiber bundle	2	10 check
	Rack: power supply	Power cables	4	14
	Rack: PP3	VCAN cables	4	7
	Dry air net	Dry air pipes	2	8
Half-shell	LUCASZ CO <sub>2</sub> plant	CO <sub>2</sub> transfer lines	2	8 / 12
	Rack: PP2	Type II cables	6 (4 power supply + 2 environmental)	20
Inlet-Middle-Outlet of CO <sub>2</sub> flow	Rack: DCS and interlock	PTC	11	3.5
Test Box environment	Rack: DCS and interlock	Humidity sensors	2	3.5
	Rack: DCS and interlock	Dew point sensors	6	5.7
	Rack: DCS and interlock	Flow meters	2	5.7
	Rack: DCS and interlock	Pressure sensors	2	5.7
	Rack: DCS and interlock	Light sensors	2	5.7
	Rack: DCS and interlock	Emergency nitrogen pipe	1	25.4

# Status Infrastrucure: Lucasz Plant at LNF



Feature	Performance
Cooling loop maximum flow	10g/s per loop ✓
Total plant flow	20g/s ✓
Min evaporating T	-30°C, depending on heat load, see graph ✓
Max evaporating T	+18°C ✓
Number of cooling loops	#2
Max DP across cooling loop	<15 Bar ✓
Cooling loop max power	2000 W ✓
Dimensions (LxWxH)	1125/1475* x 1300 x 1820 *Lite/Full version

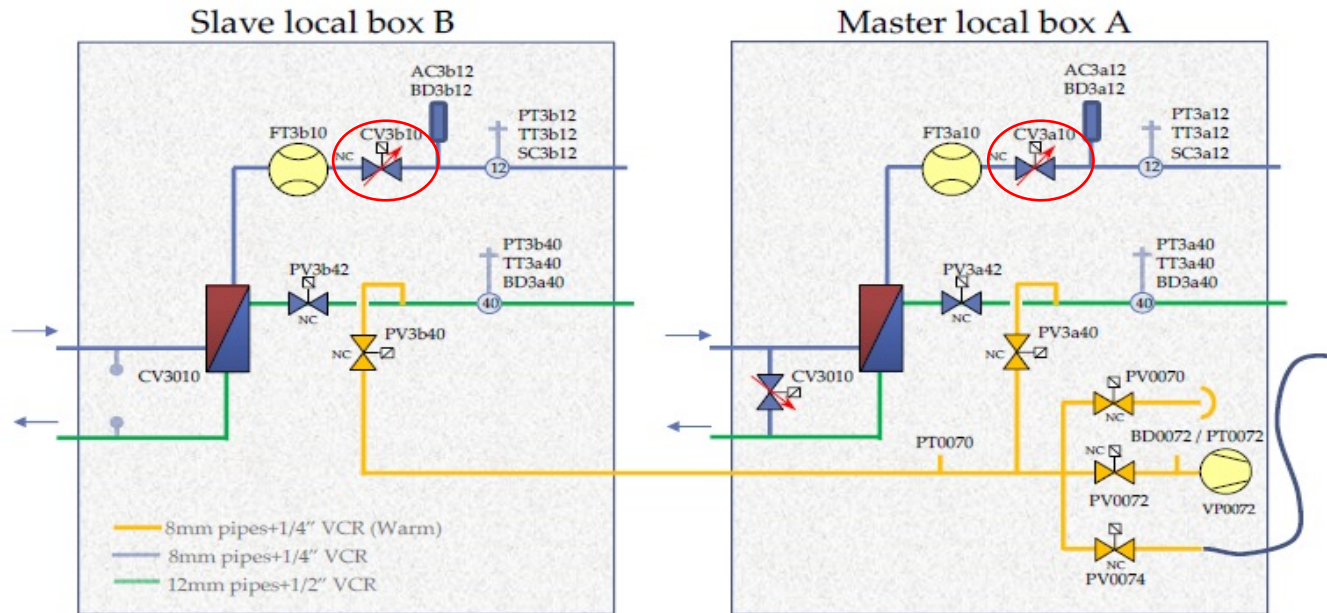


- Merging of lines to reach 20 g/s
- With VP = 0.5 proposal:
  - $T_{CO_2 \text{ evap}}$  -15 C for cold test
  - $T_{CO_2 \text{ evap}}$  +15 C for warm test

C. Ligi, G. Cesarini

G. Cesarini,  
C. Ligi

T <sub>setpoint</sub> = -20 °C				
Local Boxes	CV3a10 Valve (%)	CV3b10 Valve (%)	Dummy Load (kW)	Flow rate (g/s)
Master	83.2	/	2	10.5
Slave	/	84.2		10.5
Merging	/			21
Master	100 (non-operational condition)	/	2	12.2
Slave	/	100 (non-operational condition)		10.9
Merging	/			23.1



pump stroke set to 15 mm

# Data ewxtenders prototypes

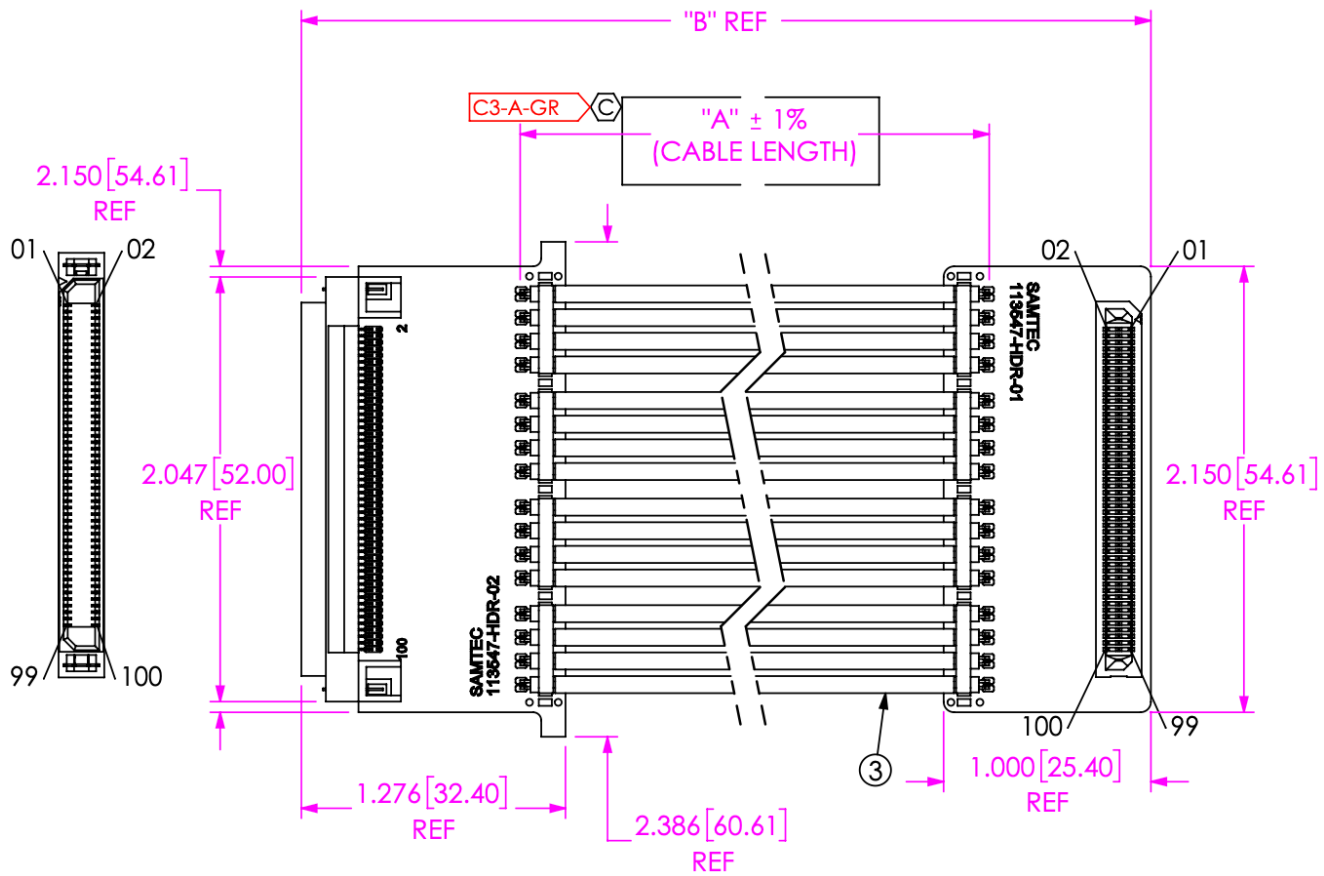
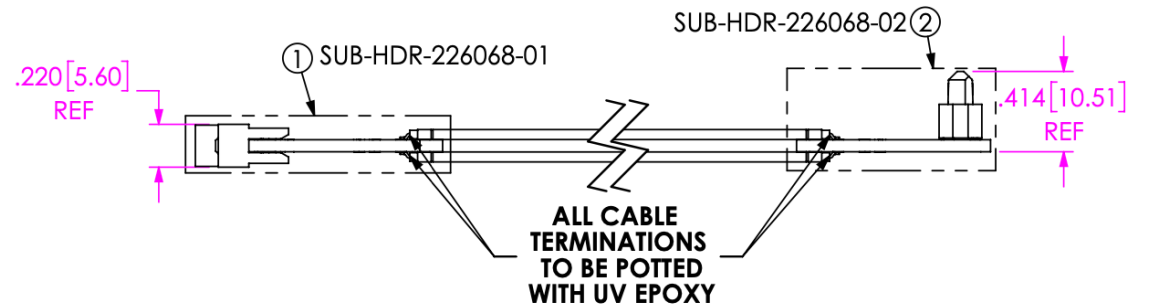
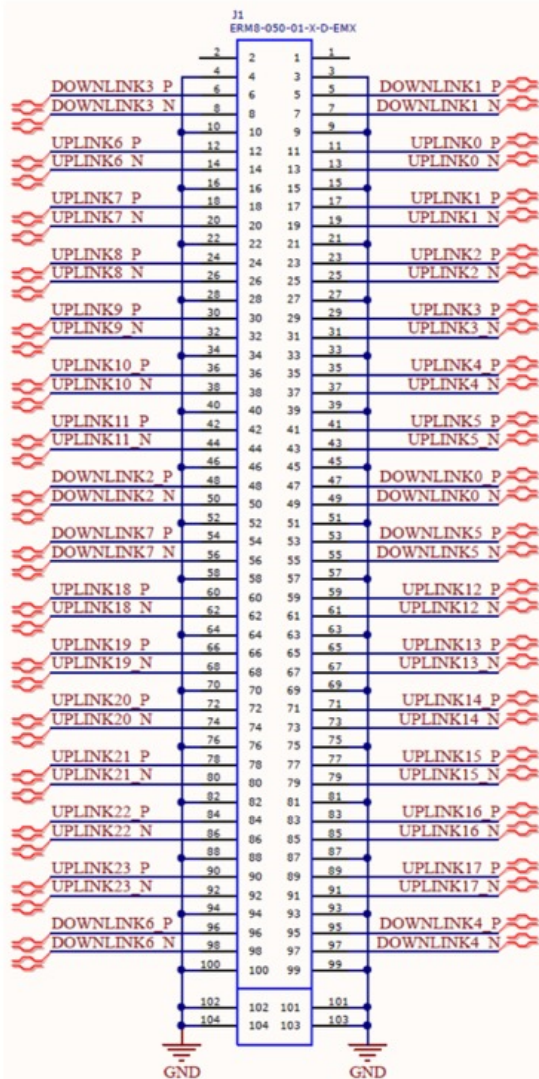


TABLE 1		
PART #	"A"	"B"
HDR-226068-01-ERDP	40.00 [1,016.0]	41.83 [1,062.5]
HDR-226068-02-ERDP	80.00 [2,032.0]	81.83 [2,078.5]
HDR-226068-03-ERDP	200.00 [5,080.0]	201.83 [5,126.5]
HDR-226068-04-ERDP	120.00 [3,048.0]	121.83 [3,094.5]



# Pin mapping



**TABLE 2**  
**SIGNAL MAPPING**

J1	NAME	J2	J1	NAME	J2	J1	NAME	J2	J1	NAME	J2
1	NC	1	51	GND	51	2	NC	2	52	GND	52
3	GND	3	53	DP	53	4	GND	4	54	DP	54
5	DP	5	55	DP	55	6	DP	6	56	DP	56
7	DP	7	57	GND	57	8	DP	8	58	GND	58
9	GND	9	59	DP	59	10	GND	10	60	DP	60
11	DP	11	61	DP	61	12	DP	12	62	DP	62
13	DP	13	63	GND	63	14	DP	14	64	GND	64
15	GND	15	65	DP	65	16	GND	16	66	DP	66
17	DP	17	67	DP	67	18	DP	18	68	DP	68
19	DP	19	69	GND	69	20	DP	20	70	GND	70
21	GND	21	71	DP	71	22	GND	22	72	DP	72
23	DP	23	73	DP	73	24	DP	24	74	DP	74
25	DP	25	75	GND	75	26	DP	26	76	GND	76
27	GND	27	77	DP	77	28	GND	28	78	DP	78
29	DP	29	79	DP	79	30	DP	30	80	DP	80
31	DP	31	81	GND	81	32	DP	32	82	GND	82
33	GND	33	83	DP	83	34	GND	34	84	DP	84
35	DP	35	85	DP	85	36	DP	36	86	DP	86
37	DP	37	87	GND	87	38	DP	38	88	GND	88
39	GND	39	89	DP	89	40	GND	40	90	DP	90
41	DP	41	91	DP	91	42	DP	42	92	DP	92
43	DP	43	93	GND	93	44	DP	44	94	GND	94
45	GND	45	95	DP	95	46	GND	46	96	DP	96
47	DP	47	97	DP	97	48	DP	48	98	DP	98
49	DP	49	99	GND	99	50	DP	50	100	GND	100

ALL GROUNDS COMMON AND TIED TO CABLE SHIELD